

8-bit Proprietary Microcontrollers

CMOS

F²MC-8FX MB95100A Series

MB95107A/F108AS/F108AW/FV100A-101

■ DESCRIPTION

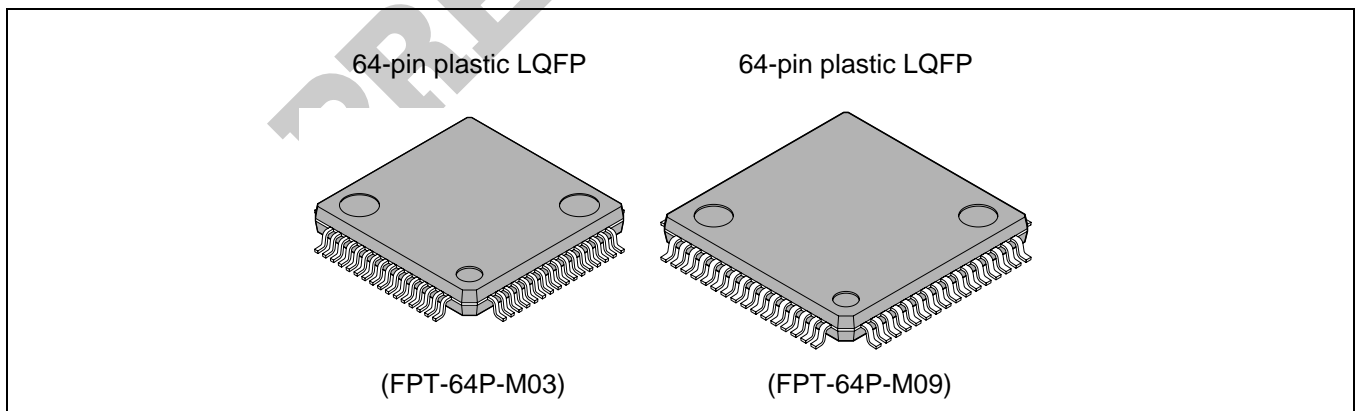
The MB95100A series is general-purpose, single-chip microcontrollers. In addition to a compact instruction set, the microcontrollers contain a variety of peripheral functions.

■ FEATURE

- F²MC-8FX CPU core
 - Instruction set optimized for controllers
 - Multiplication and division instructions
 - 16-bit arithmetic operations
 - Bit test branch instruction
 - Bit manipulation instructions etc.
- Clock
 - Main clock
 - Main PLL clock
 - Subclock (for dual clock product)
 - Sub PLL clock (for dual clock product)

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■ PACKAGES



MB95100A Series

(Continued)

- Timer
 - 8/16-bit compound timer × 2 channels
 - 16-bit reload timer
 - 8/16-bit PPG × 2 channels
 - 16-bit PPG × 2 channels
 - Timebase timer
 - Watch prescaler (for dual clock product)
- LIN-UART
 - Full duplex double buffer
 - Clock asynchronous or synchronous serial transfer capable
- UART/SIO
 - Clock asynchronous or synchronous serial transfer capable
- I²C*
 - Built-in wake-up function
- External interrupt
 - Interrupt by edge detection (rising, falling, or both edges can be selected)
 - Can be used to recover from low-power consumption modes.
- 10-bit A/D converter
 - 10-bit resolution
- Low-power consumption (standby mode)
 - Stop mode
 - Sleep mode
 - Watch mode (for dual clock product)
 - Timebase timer mode
- I/O port: Max 55
 - General-purpose I/O ports (Nch open drain) : 6 ports
 - General-purpose I/O ports (CMOS) : 49 ports

* : Purchase of Fujitsu I²C components conveys a license under the Philips I²C Patent Rights to use, these components in an I²C system provided that the system conforms to the I²C Standard Specification as defined by Philips.

MB95100A Series

■ PRODUCT LINEUP

Part number		MB95107A	MB95F108AS	MB95F108AW	MB95FV100A-101
Parameter					
Type		MASK product	FLASH product		EVA product
ROM capacity		48 KB	60 KB		
RAM capacity		2 KB			3.75 KB
Reset output		No			
Option		Selectable Single/Dual -system*2	Single-system	Dual-system	Selectable Single/Dual -system*1
CPU functions		Number of basic instructions : 136 Instruction bit length : 8 bits Instruction length : 1 to 3 bytes Data bit length : 1, 8, and 16 bits Minimum instruction execution time : 0.1 μ s (at internal 10 MHz) Interrupt processing time : 0.9 μ s (at internal 10 MHz)			
Peripheral functions	Ports (Max 55 ports)	General-purpose I/O port (Nch open drain) : 6 ports General-purpose I/O port (CMOS) : 49 ports			
	Timebase timer	Interrupt cycle : 0.5 ms, 2.05 ms, 8.2 ms, 32.8 ms (at main oscillation clock 4 MHz)			
	Watchdog timer	Reset generated cycle At main oscillation clock 10 MHz : Min 105 ms At sub oscillation clock 32.768 kHz (for dual clock product) : Min 250 ms			
	Wild register	Capable of replacing 3 bytes of data			
	I ² C bus	Master/slave sending and receiving Bus error function and arbitration function Detecting transmitting direction function Start condition repeated generation and detection functions Built-in wake-up function			
	UART/SIO	Data transfer capable in UART/SIO Full duplex double buffer, Variable data length (5/6/7/8-bit), built-in baud rate generator Transfer rate : 2400 bps to 125000 bps (at machine clock 10 MHz) NRZ type transfer format, error detected function LSB-first or MSB-first can be selected. Clock synchronous (SIO) or clock asynchronous (UART) data transfer capable			
	LIN-UART	Dedicated reload timer allowing a wide range of communication speeds to be set. Capable of data transfer synchronous or asynchronous to clock signal. LIN functions available as the LIN master or LIN slave.			
	A/D converter (12 channels)	8-bit or 10-bit resolution can be selected.			
	16-bit reload timer	Two clock modes and two counter operating modes can be selected. Square waveform output Count clock : 7 internal clocks and external clock can be selected.			

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MB95100A Series

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Part number		MB95107A	MB95F108AS	MB95F108AW	MB95FV100A-101
Parameter					
Peripheral functions	8/16-bit compound timer (2 channels)	Each channel of the timer can be used as "8-bit timer × 2 channels" or "16-bit timer × 1 channel". Built-in timer function, PWC function, PWM function, capture function and Square waveform output Count clock : 7 internal clocks and external clock can be selected.			
	16-bit PPG (2 channels)	PWM mode or one-shot mode can be selected. Counter operating clock : Eight selectable clock sources Support for external trigger start			
	8/16-bit PPG (2 channels)	Each channel of the PPG can be used as "8-bit PPG × 2 channels" or "16-bit PPG × 1 channel". Counter operating clock : Eight selectable clock sources			
	Watch counter (for dual clock product)	Count clock : Four selectable clock sources (125 ms, 250 ms, 500 ms, or 1 s) Counter value can be set from 0 to 63. (Capable of counting for 1 minute)			
	Watch prescaler (for dual clock product)	Four selectable interval times (125 ms, 250 ms, 500 ms, or 1 s)			
	External interrupt (12 channels)	Interrupt by edge detection (rising, falling, or both edges can be selected.) Can be used to recover from standby modes.			
Standby mode		Sleep, stop, watch, and timebase timer			

*1 : Change by the switch on MCU board.

*2 : Specify clock mode when ordering MASK ROM.

■ SELECT OF OSCILLATION STABILIZATION WAIT TIME (MASK PRODUCT ONLY)

For the MASK product, you can set the mask option when ordering MASK ROM to select the initial value of main clock oscillation stabilization wait time from among the following four values.

Note that the EVA and FLASH products are fixed their initial value of main clock oscillation stabilization wait time at the maximum value.

Oscillation stabilization wait time	Remarks
$(2^2-2) / F_{CH}$	0.5 μ s (at main oscillation clock 4 MHz)
$(2^{12}-2) / F_{CH}$	Approx. 1.02 ms (at main oscillation clock 4 MHz)
$(2^{13}-2) / F_{CH}$	Approx. 2.05 ms (at main oscillation clock 4 MHz)
$(2^{14}-2) / F_{CH}$	Approx. 4.10 ms (at main oscillation clock 4 MHz)

■ PACKAGES AND CORRESPONDING PRODUCTS

Part number Package	MB95107A	MB95F108AS	MB95F108AW	MB95FV100A-101
FPT-64P-M03	○	○	○	×
FPT-64P-M09	○	○	○	×
BGA-224P-M08	×	×	×	○

○ : Available

× : Unavailable

MB95100A Series

■ DIFFERENCES AMONG PRODUCTS AND NOTES ON SELECTING PRODUCTS

• Notes on Using EVA Products

The EVA product has not only the functions of the MB95100A corresponding products series but also those of other products to support software development for multiple series and models of the F²MC-8FX family. The I/O addresses for peripheral resources not used by the MB95100A series are therefore access-barred. Read/write access to these access-barred addresses may cause peripheral resources supposed to be unused to operate, resulting in unexpected malfunctions of hardware or software.

Take particular care not to use word, long word, or similar access to read or write odd numbered bytes in the prohibited areas.

Note that the values read from barred addresses are different between the EVA product and the FLASH or MASK product. Therefore, the data must not be used for software processing.

The EVA product do not support the functions of some bits in single-byte registers. Read/write access to these bits does not cause hardware malfunctions. Since the EVA, FLASH, and MASK products are designed to behave completely the same way in terms of hardware and software, you do not have to pay special attention to specific products.

• Difference of Memory Spaces

If the amount of memory on the EVA product is different from that of the FLASH or MASK product, carefully check the difference in the amount of memory from the model to be actually used when developing software.

• Current Consumption

- The current consumption of FLASH product is typically greater than for MASK ROM product.
- For details of current consumption, refer to “■ ELECTRICAL CHARACTERISTICS”.

• Package

For details of information on each package, see “■ PACKAGE DIMENSIONS”.

• Operating voltage

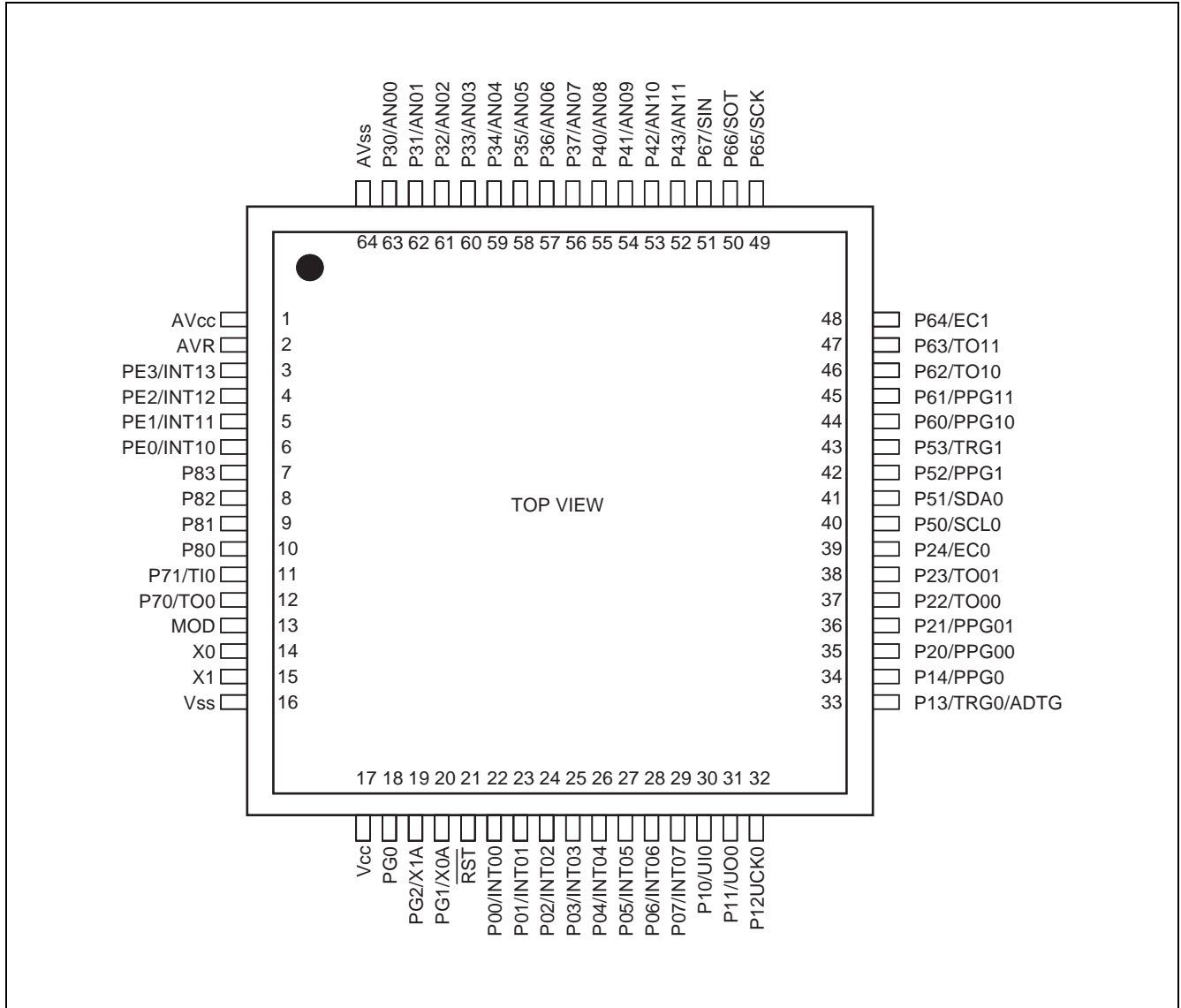
The operating voltage are different among the EVA, FLASH and MASK products.

For details of operating voltage, refer to “■ ELECTRICAL CHARACTERISTICS”

• Difference between $\overline{\text{RST}}$ and MOD pins

The $\overline{\text{RST}}$ and MOD pins are hysteresis inputs on the MASK product. A pull - down resistor is provided for the MOD pin of the MASK product.

■ PIN ASSIGNMENT



MB95100A Series

■ PIN DESCRIPTION

Pin no.	Pin name	Circuit type	Description
1	AVcc	—	A/D power supply pin
2	AVR	—	A/D reference input pin
3	PE3/INT13	P	General-purpose I/O port The pins are shared with the external interrupt input.
4	PE2/INT12		
5	PE1/INT11		
6	PE0/INT10		
7	P83	O	General-purpose I/O port
8	P82		
9	P81		
10	P80		
11	P71/TI0	H	General-purpose I/O port. The pin is shared with 16 - bit reload timer ch0 output.
12	P70/TO0		General-purpose I/O port. The pin is shared with 16 - bit reload timer ch0 input.
13	MOD	B	An operating mode designation pin
14	X0	A	Crystal oscillation pin
15	X1		
16	Vss	—	Power supply pin (GND)
17	Vcc	—	Power supply pin
18	PG0	H	General-purpose I/O port.
19	PG2/X1A	H/A	Single-system product is general-purpose port. Dual-system product is Crystal oscillation pin (32 kHz).
20	PG1/X0A		
21	$\overline{\text{RST}}$	B'	Reset pin
22	P00/INT00	C	General-purpose I/O port. The pins are shared with external interrupt input. Large current port.
23	P01/INT01		
24	P02/INT02		
25	P03/INT03		
26	P04/INT04		
27	P05/INT05		
28	P06/INT06		
29	P07/INT07		
30	P10/UI0	G	General-purpose I/O port. The pin is shared with UART/SIO ch0 data input.

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MB95100A Series

Pin no.	Pin name	Circuit type	Description
31	P11/UO0	H	General-purpose I/O port. The pin is shared with UART/SIO ch0 data output.
32	P12/UCK0		General-purpose I/O port. The pin is shared with UART/SIO ch0 clock I/O.
33	P13/TRG0/ ADTG		General-purpose I/O port. The pin is shared with 16-bit PPG ch0 trigger input (TRG0) and A/D trigger input (ADTG).
34	P14/PPG0		General-purpose I/O port. The pin is shared with 16-bit PPG ch0 output.
35	P20/PPG00	H	General-purpose I/O port. The pins are shared with 8/16-bit PPG ch0 output.
36	P21/PPG01		
37	P22/TO00		General-purpose I/O port. The pins are shared with 8/16-bit compound timer ch0 output.
38	P23/TO01		
39	P24/EC0	General-purpose I/O port. The pin is shared with 8/16-bit compound timer ch0 clock input.	
40	P50/SCL0	I	General-purpose I/O port. The pin is shared with I ² C ch0 clock I/O.
41	P51/SDA0		General-purpose I/O port. The pin is shared with I ² C ch0 data I/O.
42	P52/PPG1	H	General-purpose I/O port. The pin is shared with 16-bit PPG ch1 output.
43	P53/TRG1		General-purpose I/O port. The pin is shared with 16-bit PPG ch1 trigger input.
44	P60/PPG10	K	General-purpose I/O port. The pins are shared with 8/16-bit PPG ch1 output.
45	P61/PPG11		
46	P62/TO10		General-purpose I/O port. The pins are shared with 8/16-bit compound timer ch1 output.
47	P63/TO11		
48	P64/EC1		General-purpose I/O port. The pin is shared with 8/16-bit compound timer ch1 clock input.
49	P65/SCK		General-purpose I/O port. The pin is shared with LIN-UART clock I/O.
50	P66/SOT		General-purpose I/O port. The pin is shared with LIN-UART data output.
51	P67/SIN	L	General-purpose I/O port. The pin is shared with LIN-UART data input.
52	P43/AN11	J	General-purpose I/O port. The pins are shared with A/D analog input.
53	P42/AN10		
54	P41/AN09		
55	P40/AN08		

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MB95100A Series

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Pin no.	Pin name	Circuit type	Description
56	P37/AN07	J	General-purpose I/O port. The pins are shared with A/D analog input.
57	P36/AN06		
58	P35/AN05		
59	P34/AN04		
60	P33/AN03		
61	P32/AN02		
62	P31/AN01		
63	P30/AN00		
64	AVss	—	A/D power supply pin (GND)

■ I/O CIRCUIT TYPE

Type	Circuit	Remarks
A	<p>X1 (X1A) X0 (X0A) Standby control</p>	<ul style="list-style-type: none"> • Oscillation circuit • High-speed side Feedback resistance value : approx. 1 MΩ • Low-speed side Feedback resistance : approx. 24 MΩ (EVA product : approx. 10 MΩ) Dumping resistance : approx. 144 kΩ (EVA product : without dumping resistance)
B	<p>R</p>	<ul style="list-style-type: none"> • Only for input Hysteresis input only for MASK product With pull-down resistor only for MASK product
B'		<ul style="list-style-type: none"> • Hysteresis input only for MASK product
C	<p>Pch Nch Standby control External interrupt enable</p>	<ul style="list-style-type: none"> • CMOS output • Hysteresis input
G	<p>R Pch Nch Pull-up control Standby control</p>	<ul style="list-style-type: none"> • CMOS output • CMOS input • Hysteresis input • With pull - up control
H	<p>R Pch Nch Pull-up control Standby control</p>	<ul style="list-style-type: none"> • CMOS output • Hysteresis input • With pull - up control

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MB95100A Series

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Type	Circuit	Remarks
I		<ul style="list-style-type: none"> • Nch open drain output • CMOS input • Hysteresis input
J		<ul style="list-style-type: none"> • CMOS output • Hysteresis input • Analog input • With pull - up control
K		<ul style="list-style-type: none"> • CMOS output • Hysteresis input
L		<ul style="list-style-type: none"> • CMOS output • CMOS input • Hysteresis input
O		<ul style="list-style-type: none"> • Nch open drain output • Hysteresis input
P		<ul style="list-style-type: none"> • CMOS output • Hysteresis input • With pull - up control

■ HANDLING DEVICES

• Preventing Latchup

Care must be taken to ensure that maximum voltage ratings are not exceeded when they are used.

Latchup may occur on CMOS ICs if voltage higher than V_{CC} or lower than V_{SS} is applied to input and output pins other than medium- and high-withstand voltage pins or if higher than the rating voltage is applied between V_{CC} and V_{SS} .

When latchup occurs, power supply current increases rapidly and might thermally damage elements.

Also, take care to prevent the analog power supply voltage (AV_{CC} , AVR) and analog input voltage from exceeding the digital power supply voltage (V_{CC}) when the analog system power supply is turned on or off.

• Stable Supply Voltage

Supply voltage should be stabilized.

A sudden change in power-supply voltage may cause a malfunction even within the guaranteed operating range of the V_{CC} power-supply voltage.

For stabilization, in principle, keep the variation in V_{CC} ripple (p-p value) in a commercial frequency range (50 Hz to 60 Hz) not to exceed 10% of the V_{CC} value and suppress the voltage variation so that the transient variation rate does not exceed 0.1 V/ms during a momentary change such as when the power supply is switched.

• Treatment of Unused Input Pin

An unused input pin may cause a malfunction if it is left open. It should be connected to a pull-up or pull-down resistor.

• Treatment of Power Supply Pins on A/D Converter

Connect to be $AV_{CC} = V_{CC}$ and $AV_{SS} = AVR = V_{SS}$ even if the A/D converter is not in use.

• Precautions for Use of External Clock

Even when an external clock is used, oscillation stabilization wait time is required for power-on reset, wake-up from subclock mode or stop mode.

• Precaution against Noise to the External Reset Pin (\overline{RST})

An input of a reset pulse below the specified level to the external reset pin (\overline{RST}) may cause malfunctions. Be sure not to allow an input of a reset pulse below the specified level to the external reset pin (\overline{RST}).

MB95100A Series

■ PROGRAMMING FLASH MICROCONTROLLERS USING PARALLEL PROGRAMMER

• Supported Parallel Programmers and Adapters

The following table lists supported parallel programmers and adapters.

Package	Applicable adapter model	Parallel programmers
FPT-64P-M03	TEF110-108F35AP	AF9708 (Ver 02.35G or more)
FPT-64P-M09	TEF110-108F36AP	AF9709/B (Ver 02.35G or more) AF9723+AF9834 (Ver 02.08E or more)

Notes: • Set all of the J1 to J3 switches on the adapter to "95F108".

- For information on applicable adapter models and parallel programmers, contact the following:
Flash Support Group, Inc. TEL: 053-428-8380

• Sector Configuration

The individual sectors of flash memory correspond to addresses used for CPU access and programming by the parallel programmer as follows:

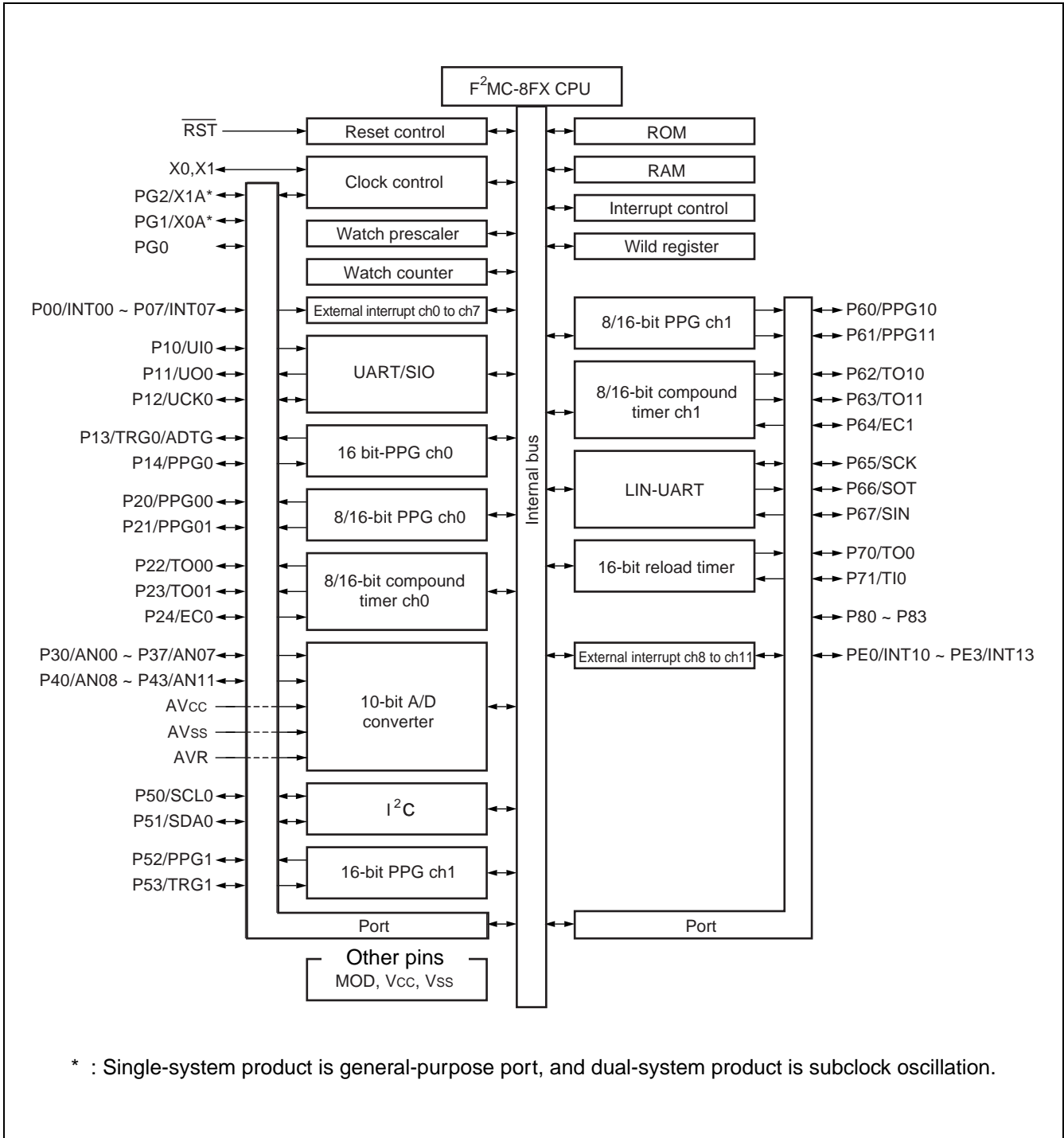
FLASH memory	CPU address	Writer address*
SA1 (4 Kbytes)	1000 _H	71000 _H
	1FFF _H	71FFF _H
SA2 (4Kbytes)	2000 _H	72000 _H
	2FFF _H	72FFF _H
SA3 (4 Kbytes)	3000 _H	73000 _H
	3FFF _H	73FFF _H
SA4 (16 Kbytes)	4000 _H	74000 _H
	7FFF _H	77FFF _H
SA5 (16 Kbytes)	8000 _H	78000 _H
	BFFF _H	7BFFF _H
SA6 (4 Kbytes)	C000 _H	7C000 _H
	CFFF _H	7CFFF _H
SA7 (4 Kbytes)	D000 _H	7D000 _H
	DFFF _H	7DFFF _H
SA8 (4 Kbytes)	E000 _H	7E000 _H
	EFFF _H	7EFFF _H
SA9 (4 Kbytes)	F000 _H	7F000 _H
	FFFF _H	7FFFF _H

*: Programmer addresses are equivalent to CPU addresses, used when the parallel programmer programs data into flash memory.
These programmer addresses are used for the parallel programmer to program or erase data in flash memory.

• Programming Method

- 1) Set the type code of the parallel programmer to 17226.
- 2) Load program data to programmer addresses 71000_H to 7FFFF_H.
- 3) Programmed by parallel programmer

■ BLOCK DIAGRAM



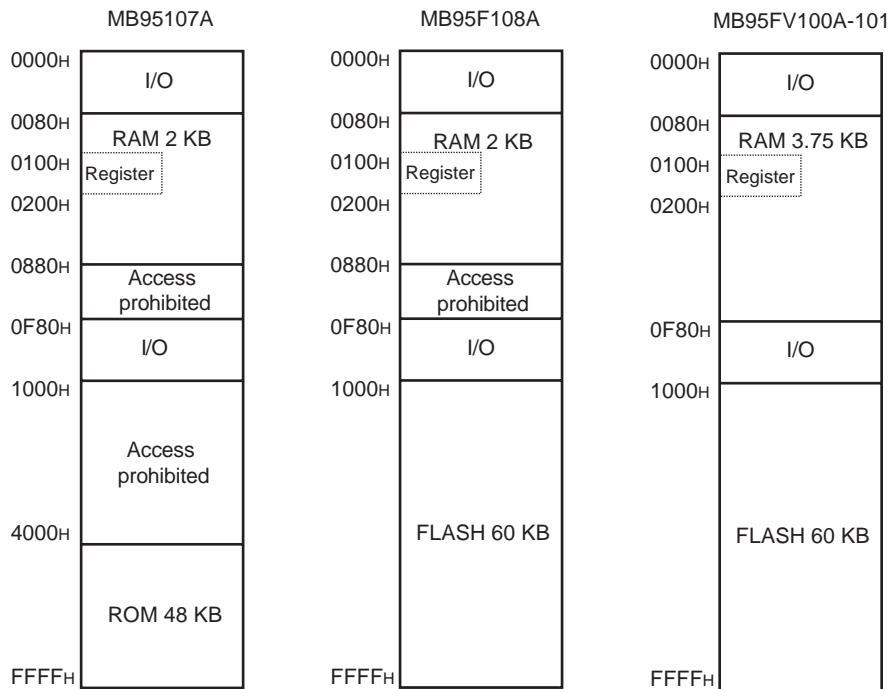
MB95100A Series

■ CPU CORE

1. Memory space

Memory space of the MB95100A series is 64 Kbytes and consists of I/O area, data area, and program area. The memory space includes special - purpose areas such as the general - purpose registers and vector table. Memory map of the MB95100A series is shown in below.

• Memory Map



2. Register

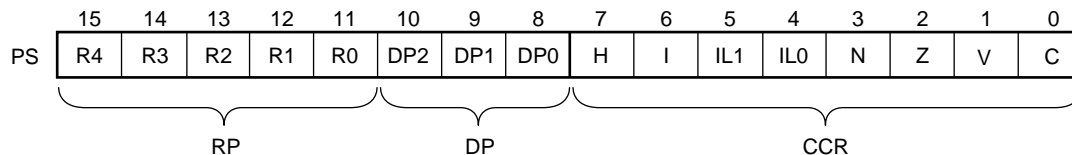
The MB95100A series has two types of registers; dedicated registers in the CPU and general-purpose registers in the memory. The dedicated registers are as follows:

- Program counter (PC) : A 16-bit register to indicate locations where instructions are stored.
- Accumulator (A) : A 16-bit register for temporary storage of arithmetic operations. In the case of an 8-bit data processing instruction, the lower one byte is used.
- Temporary accumulator (T) : A 16-bit register which performs arithmetic operations with the accumulator. In the case of an 8-bit data processing instruction, the lower one byte is used.
- Index register (IX) : A 16-bit register for index modification
- Extra pointer (EP) : A 16-bit pointer to point to a memory address.
- Stack pointer (SP) : A 16-bit register to indicate a stack area.
- Program status (PS) : A 16-bit register for storing a register bank pointer, a direct bank pointer, and a condition code register

← 16-bit →		Initial Value
PC	: Program counter	FFFD _H
A	: Accumulator	0000 _H
T	: Temporary accumulator	0000 _H
IX	: Index register	0000 _H
EP	: Extra pointer	0000 _H
SP	: Stack pointer	0000 _H
PS	: Program status	0030 _H

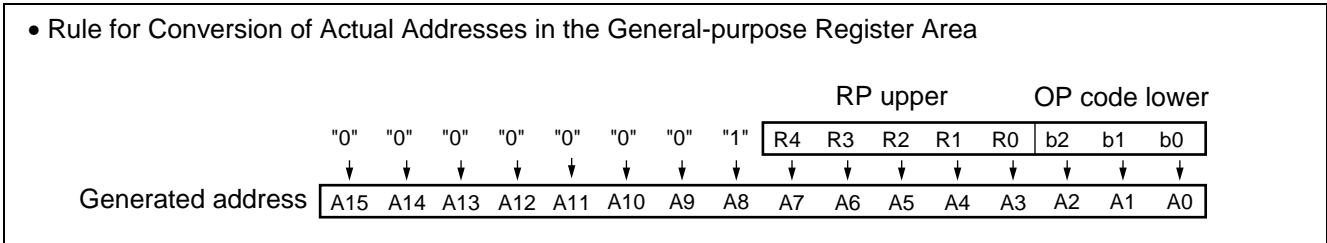
The PS can further be divided into higher 8 bits for use as a register bank pointer (RP) and a direct bank pointer (DP) and the lower 8 bits for use as a condition code register (CCR) . (See the diagram below.)

• Structure of the program status



MB95100A Series

The RP indicates the address of the register bank currently being used. The relationship between the content of RP and the real address conforms to the conversion rule illustrated below:



The DP specifies the area for mapping instructions (16 different instructions such as MOV A, dir) using direct addresses to 0080H to 00FFH.

Direct bank pointer (DP2 to DP0)	Specified address area	Mapping area
Don't care	0000H to 007FH	0000H to 007FH (without mapping)
000B (initial value)	0080H to 00FFH	0080H to 00FFH (without mapping)
001B		0100H to 017FH
010B		0180H to 01FFH
011B		0200H to 027FH
100B		0280H to 02FFH
101B		0300H to 037FH
110B		0380H to 03FFH
111B		0400H to 047FH

The CCR consists of the bits indicating arithmetic operation results or transfer data contents and the bits that control CPU operations at interrupt.

- H flag : Set to "1" when a carry or a borrow from bit 3 to bit 4 occurs as a result of an arithmetic operation. Cleared to "0" otherwise. This flag is for decimal adjustment instructions.
- I flag : Interrupt is enabled when this flag is set to "1". Interrupt is disabled when this flag is set to "0". The flag is set to "0" when reset.
- IL1, IL0 : Indicates the level of the interrupt currently enabled. Processes an interrupt only if its request level is higher than the value indicated by this bit.

IL1	ILO	Interrupt level	Priority
0	0	0	High ↑ ↓ Low = no interruption
0	1	1	
1	0	2	
1	1	3	

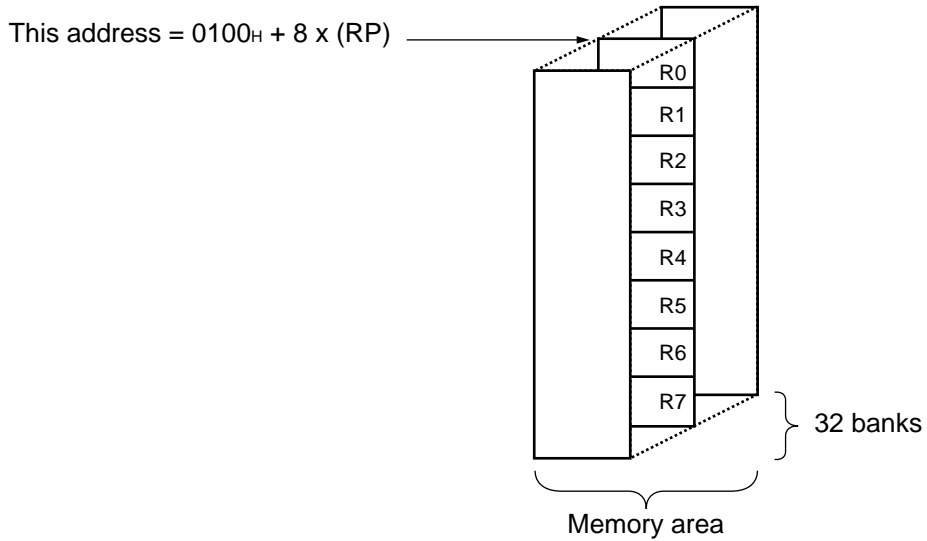
- N flag : Set to "1" if the MSB is set to "1" as the result of an arithmetic operation. Cleared to "0" when the bit is set to "0".
- Z flag : Set to "1" when an arithmetic operation results in 0. Cleared to "0" otherwise.
- V flag : Set to "1" if the complement on 2 overflows as a result of an arithmetic operation. Cleared to "0" otherwise.
- C flag : Set to "1" when a carry or a borrow from bit 7 occurs as a result of an arithmetic operation. Cleared to "0" otherwise. Set to the shift-out value in the case of a shift instruction.

The following general-purpose registers are provided:

General-purpose registers: 8-bit data storage registers

The general-purpose registers are 8 bits and located in the register banks on the memory. One bank contains eight registers. Up to a total of 32 banks can be used on the MB95100A series. The bank currently in use is indicated by the register bank pointer (RP).

- Register Bank Configuration



MB95100A Series

■ I/O MAP

Address	Register abbreviation	Register name	R/W	Initial value
0000 _H	PDR0	Port 0 data register	R/W	00000000 _B
0001 _H	DDR0	Port 0 direction register	R/W	00000000 _B
0002 _H	PDR1	Port 1 data register	R/W	00000000 _B
0003 _H	DDR1	Port 1 direction register	R/W	00000000 _B
0004 _H	—	(Vacancy)	—	—
0005 _H	WATR	Oscillation stabilization wait time setting register	R/W	11111111 _B
0006 _H	PLLC	PLL control register	R/W	00000000 _B
0007 _H	SYCC	System clock control register	R/W	1010X011 _B
0008 _H	STBC	Standby control register	R/W	00000000 _B
0009 _H	RSRR	Reset source register	R	XXXXXXXX _B
000A _H	TBTC	Timebase timer control register	R/W	00000000 _B
000B _H	WPCR	Watch prescaler control register	R/W	00000000 _B
000C _H	WDTC	Watchdog timer control register	R/W	00000000 _B
000D _H	—	(Vacancy)	—	—
000E _H	PDR2	Port 2 data register	R/W	00000000 _B
000F _H	DDR2	Port 2 direction register	R/W	00000000 _B
0010 _H	PDR3	Port 3 data register	R/W	00000000 _B
0011 _H	DDR3	Port 3 direction register	R/W	00000000 _B
0012 _H	PDR4	Port 4 data register	R/W	00000000 _B
0013 _H	DDR4	Port 4 direction register	R/W	00000000 _B
0014 _H	PDR5	Port 5 data register	R/W	00000000 _B
0015 _H	DDR5	Port 5 direction register	R/W	00000000 _B
0016 _H	PDR6	Port 6 data register	R/W	00000000 _B
0017 _H	DDR6	Port 6 direction register	R/W	00000000 _B
0018 _H	PDR7	Port 7 data register	R/W	00000000 _B
0019 _H	DDR7	Port 7 direction register	R/W	00000000 _B
001A _H	PDR8	Port 8 data register	R/W	00000000 _B
001B _H	DDR8	Port 8 direction register	R/W	00000000 _B
001C _H to 0025 _H	—	(Vacancy)	—	—
0026 _H	PDRE	Port E data register	R/W	00000000 _B
0027 _H	DDRE	Port E direction register	R/W	00000000 _B
0028 _H	—	(Vacancy)	—	—
0029 _H				
002A _H	PDRG	Port G data register	R/W	00000000 _B

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MB95100A Series

Address	Register abbreviation	Register name	R/W	Initial value
002B _H	DDRG	Port G direction register	R/W	00000000 _B
002C _H	—	(Vacancy)	—	—
002D _H	PUL1	Port 1 pull - up register	R/W	00000000 _B
002E _H	PUL2	Port 2 pull - up register	R/W	00000000 _B
002F _H	PUL3	Port 3 pull - up register	R/W	00000000 _B
0030 _H	PUL4	Port 4 pull - up register	R/W	00000000 _B
0031 _H	PUL5	Port 5 pull - up register	R/W	00000000 _B
0032 _H	PUL7	Port 7 pull - up register	R/W	00000000 _B
0033 _H	—	(Vacancy)	—	—
0034 _H	PULE	Port E pull - up register	R/W	00000000 _B
0035 _H	PULG	Port G pull - up register	R/W	00000000 _B
0036 _H	T01CR1	8/16-bit compound timer 01 control status register 1 ch0	R/W	00000000 _B
0037 _H	T00CR1	8/16-bit compound timer 00 control status register 1 ch0	R/W	00000000 _B
0038 _H	T11CR1	8/16-bit compound timer 11 control status register 1 ch1	R/W	00000000 _B
0039 _H	T10CR1	8/16-bit compound timer 10 control status register 1 ch1	R/W	00000000 _B
003A _H	PC01	8/16-bit PPG1 control register ch0	R/W	00000000 _B
003B _H	PC00	8/16-bit PPG0 control register ch0	R/W	00000000 _B
003C _H	PC11	8/16-bit PPG1 control register ch1	R/W	00000000 _B
003D _H	PC10	8/16-bit PPG0 control register ch1	R/W	00000000 _B
003E _H	TMCSRH0	16-bit reload timer control status register (Upper byte) ch0	R/W	00000000 _B
003F _H	TMCSRL0	16-bit reload timer control status register (Lower byte) ch0	R/W	00000000 _B
0040 _H	—	(Vacancy)	—	—
0041 _H				
0042 _H	PCNTH0	16-bit PPG control status register (Upper byte) ch0	R/W	00000000 _B
0043 _H	PCNTL0	16-bit PPG control status register (Lower byte) ch0	R/W	00000000 _B
0044 _H	PCNTH1	16-bit PPG control status register (Upper byte) ch1	R/W	00000000 _B
0045 _H	PCNTL1	16-bit PPG control status register (Lower byte) ch1	R/W	00000000 _B
0046 _H	—	(Vacancy)	—	—
0047 _H				
0048 _H	EIC00	External interrupt circuit control register ch0/1	R/W	00000000 _B
0049 _H	EIC10	External interrupt circuit control register ch2/3	R/W	00000000 _B
004A _H	EIC20	External interrupt circuit control register ch4/5	R/W	00000000 _B
004B _H	EIC30	External interrupt circuit control register ch6/7	R/W	00000000 _B
004C _H	EIC01	External interrupt circuit control register ch8/9	R/W	00000000 _B
004D _H	EIC11	External interrupt circuit control register ch10/11	R/W	00000000 _B

(Continued)

MB95100A Series

Address	Register abbreviation	Register name	R/W	Initial value
004E _H	—	(Vacancy)	—	—
004F _H				
0050 _H	SCR	LIN-UART serial control register	R/W	00000000 _B
0051 _H	SMR	LIN-UART serial mode register	R/W	00000000 _B
0052 _H	SSR	LIN-UART serial status register	R/W	00001000 _B
0053 _H	RDR/TDR	LIN-UART reception/transmission data register	R/W	00000000 _B
0054 _H	ESCR	LIN-UART extended status control register	R/W	00000100 _B
0055 _H	ECCR	LIN-UART extended communication control register	R/W	000000XX _B
0056 _H	SMC10	UART/SIO serial mode control register 1 ch0	R/W	00000000 _B
0057 _H	SMC20	UART/SIO serial mode control register 2 ch0	R/W	00100000 _B
0058 _H	SSR0	UART/SIO serial status register ch0	R/W	00000001 _B
0059 _H	TDR0	UART/SIO serial output data register ch0	R/W	00000000 _B
005A _H	RDR0	UART/SIO serial input data register ch0	R	00000000 _B
005B _H to 005F _H	—	(Vacancy)	—	—
0060 _H	IBCR00	I ² C bus control register 0 ch0	R/W	00000000 _B
0061 _H	IBCR10	I ² C bus control register 1 ch0	R/W	00000000 _B
0062 _H	IBSR0	I ² C bus status register ch0	R	00000000 _B
0063 _H	IDDR0	I ² C data register ch0	R/W	00000000 _B
0064 _H	IAAR0	I ² C address register ch0	R/W	00000000 _B
0065 _H	ICCR0	I ² C clock control register ch0	R/W	00000000 _B
0066 _H to 006B _H	—	(Vacancy)	—	—
006C _H	ADC1	A/D control register 1	R/W	00000000 _B
006D _H	ADC2	A/D control register 2	R/W	00000000 _B
006E _H	ADDH	A/D data register (Upper byte)	R/W	00000000 _B
006F _H	ADDL	A/D data register (Lower byte)	R/W	00000000 _B
0070 _H	WCSR	Watch counter status register	R/W	00000000 _B
0071 _H	—	(Vacancy)	—	—
0072 _H	FSR	FLASH memory status register	R/W	000X0000 _B
0073 _H	SWRE0	FLASH memory sector writing control register 0	R/W	00000000 _B
0074 _H	SWRE1	FLASH memory sector writing control register 1	R/W	00000000 _B
0075 _H	—	(Vacancy)	—	—
0076 _H	WREN	Wild register address compare enable register	R/W	00000000 _B
0077 _H	WROR	Wild register data test setting register	R/W	00000000 _B

(Continued)

MB95100A Series

Address	Register abbreviation	Register name	R/W	Initial value
0078 _H	—	(Mirror of register bank pointer (RP) and direct bank pointer (DP))	—	—
0079 _H	ILR0	Interrupt level setting register 0	R/W	11111111 _B
007A _H	ILR1	Interrupt level setting register 1	R/W	11111111 _B
007B _H	ILR2	Interrupt level setting register 2	R/W	11111111 _B
007C _H	ILR3	Interrupt level setting register 3	R/W	11111111 _B
007D _H	ILR4	Interrupt level setting register 4	R/W	11111111 _B
007E _H	ILR5	Interrupt level setting register 5	R/W	11111111 _B
007F _H	—	(Vacancy)	—	—
0F80 _H	WRARH0	Wild register address setting register (Upper byte) ch0	R/W	00000000 _B
0F81 _H	WRARL0	Wild register address setting register (Lower byte) ch0	R/W	00000000 _B
0F82 _H	WRDR0	Wild register data setting register ch0	R/W	00000000 _B
0F83 _H	WRARH1	Wild register address setting register (Upper byte) ch1	R/W	00000000 _B
0F84 _H	WRARL1	Wild register address setting register (Lower byte) ch1	R/W	00000000 _B
0F85 _H	WRDR1	Wild register data setting register ch1	R/W	00000000 _B
0F86 _H	WRARH2	Wild register address setting register (Upper byte) ch2	R/W	00000000 _B
0F87 _H	WRARL2	Wild register address setting register (Lower byte) ch2	R/W	00000000 _B
0F88 _H	WRDR2	Wild register data setting register ch2	R/W	00000000 _B
0F89 _H to 0F91 _H	—	(Vacancy)	—	—
0F92 _H	T01CR0	8/16-bit compound timer 01 control status register 0 ch0	R/W	00000000 _B
0F93 _H	T00CR0	8/16-bit compound timer 00 control status register 0 ch0	R/W	00000000 _B
0F94 _H	T01DR	8/16-bit compound timer 01 data register ch0	R/W	00000000 _B
0F95 _H	T00DR	8/16-bit compound timer 00 data register ch0	R/W	00000000 _B
0F96 _H	TMCR0	8/16-bit compound timer 00/01 timer mode control register ch0	R/W	00000000 _B
0F97 _H	T11CR0	8/16-bit compound timer 11 control status register 0 ch1	R/W	00000000 _B
0F98 _H	T10CR0	8/16-bit compound timer 10 control status register 0 ch1	R/W	00000000 _B
0F99 _H	T11DR	8/16-bit compound timer 11 data register ch1	R/W	00000000 _B
0F9A _H	T10DR	8/16-bit compound timer 10 data register ch1	R/W	00000000 _B
0F9B _H	TMCR1	8/16-bit compound timer 10/11 timer mode control register ch1	R/W	00000000 _B
0F9C _H	PPS01	8/16-bit PPG1 cycle setting buffer register ch0	R/W	11111111 _B
0F9D _H	PPS00	8/16-bit PPG0 cycle setting buffer register ch0	R/W	11111111 _B
0F9E _H	PDS01	8/16-bit PPG1 duty setting buffer register ch0	R/W	11111111 _B
0F9F _H	PDS00	8/16-bit PPG0 duty setting buffer register ch0	R/W	11111111 _B

(Continued)

MB95100A Series

Address	Register abbreviation	Register name	R/W	Initial value
0FA0 _H	PPS11	8/16-bit PPG1 cycle setting buffer register ch1	R/W	11111111 _B
0FA1 _H	PPS10	8/16-bit PPG0 cycle setting buffer register ch1	R/W	11111111 _B
0FA2 _H	PDS11	8/16-bit PPG1 duty setting buffer register ch1	R/W	11111111 _B
0FA3 _H	PDS10	8/16-bit PPG0 duty setting buffer register ch1	R/W	11111111 _B
0FA4 _H	PPGS	8/16-bit PPG start register	R/W	00000000 _B
0FA5 _H	REVC	8/16-bit PPG output inversion register	R/W	00000000 _B
0FA6 _H	TMRH0/ TMRLRH0	16-bit timer register (Upper byte) ch0/ 16-bit reload register (Upper byte) ch0	R/W	00000000 _B
0FA7 _H	TMRL0/ TMRLRLO	16-bit timer register (Lower byte) ch0/ 16-bit reload register (Lower byte) ch0	R/W	00000000 _B
0FA8 _H	—	(Vacancy)	—	—
0FA9 _H				
0FAA _H	PDCRH0	16-bit PPG down counter register (Upper byte) ch0	R	00000000 _B
0FAB _H	PDCRL0	16-bit PPG down counter register (Lower byte) ch0	R	00000000 _B
0FAC _H	PCSRH0	16-bit PPG cycle setting buffer register (Upper byte) ch0	R/W	11111111 _B
0FAD _H	PCSRL0	16-bit PPG cycle setting buffer register (Lower byte) ch0	R/W	11111111 _B
0FAE _H	PDUTH0	16-bit PPG duty setting buffer register (Upper byte) ch0	R/W	11111111 _B
0FAF _H	PDUTL0	16-bit PPG duty setting buffer register (Lower byte) ch0	R/W	11111111 _B
0FB0 _H	PDCRH1	16-bit PPG down counter register (Upper byte) ch1	R	00000000 _B
0FB1 _H	PDCRL1	16-bit PPG down counter register (Lower byte) ch1	R	00000000 _B
0FB2 _H	PCSRH1	16-bit PPG cycle setting buffer register (Upper byte) ch1	R/W	11111111 _B
0FB3 _H	PCSRL1	16-bit PPG cycle setting buffer register (Lower byte) ch1	R/W	11111111 _B
0FB4 _H	PDUTH1	16-bit PPG duty setting buffer register (Upper byte) ch1	R/W	11111111 _B
0FB5 _H	PDUTL1	16-bit PPG duty setting buffer register (Lower byte) ch1	R/W	11111111 _B
0FB6 _H to 0FBB _H	—	(Vacancy)	—	—
0FBC _H	BGR1	LIN-UART baud rate generator register 1	R/W	00000000 _B
0FBD _H	BGR0	LIN-UART baud rate generator register 0	R/W	00000000 _B
0FBE _H	PSSR0	UART/SIO prescaler selection register ch0	R/W	00000000 _B
0FBF _H	BRSR0	UART/SIO baud rate setting register ch0	R/W	00000000 _B
0FC0 _H	—	(Vacancy)	—	—
0FC1 _H				
0FC2 _H	AIDRH	A/D input disable register (Upper byte)	R/W	00000000 _B
0FC3 _H	AIDRL	A/D input disable register (Lower byte)	R/W	00000000 _B
0FC4 _H to 0FE2 _H	—	(Vacancy)	—	—

(Continued)

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Address	Register abbreviation	Register name	R/W	Initial value
0FE3 _H	WCDR	Watch counter data register	R/W	00111111 _B
0FE4 _H to 0FED _H	—	(Vacancy)	—	—
0FEE _H	ILSR	Input level select register	R/W	00000000 _B
0FEF _H	WICR	Interrupt pin control register	R/W	01000000 _B
0FF0 _H to 0FFF _H	—	(Vacancy)	—	—

- Read/write access symbols

R/W : Readable and Writable

R : Read only

W : Write only

- Initial value symbols

0 : The initial value of this bit is "0".

1 : The initial value of this bit is "1".

X : The initial value of this bit is undefined.

MB95100A Series

■ INTERRUPT SOURCE TABLE

Interrupt source	Interrupt request number	Vector table address		Bit name of interrupt level setting register	Same level priority order (at simultaneous occurrence)
		Upper	Lower		
External interrupt ch0	IRQ0	FFFA _H	FFFB _H	L00 [1 : 0]	<div style="display: flex; align-items: center; justify-content: center;"> <div style="margin-right: 10px;">High</div> <div style="flex-grow: 1; border-left: 1px solid black; position: relative;"> <div style="position: absolute; top: -10px; left: 50%; transform: translate(-50%, -50%);">↑</div> <div style="position: absolute; bottom: -10px; left: 50%; transform: translate(-50%, -50%);">↓</div> </div> <div style="margin-left: 10px;">Low</div> </div>
External interrupt ch4					
External interrupt ch1	IRQ1	FFF8 _H	FFF9 _H	L01 [1 : 0]	
External interrupt ch5					
External interrupt ch2	IRQ2	FFF6 _H	FFF7 _H	L02 [1 : 0]	
External interrupt ch6					
External interrupt ch3	IRQ3	FFF4 _H	FFF5 _H	L03 [1 : 0]	
External interrupt ch7					
UART/SIO ch0	IRQ4	FFF2 _H	FFF3 _H	L04 [1 : 0]	
8/16-bit compound timer ch0 (Lower)	IRQ5	FFF0 _H	FFF1 _H	L05 [1 : 0]	
8/16-bit compound timer ch0 (Upper)	IRQ6	FFEE _H	FFEF _H	L06 [1 : 0]	
LIN-UART (reception)	IRQ7	FFEC _H	FFED _H	L07 [1 : 0]	
LIN-UART (transmission)	IRQ8	FFEA _H	FFEB _H	L08 [1 : 0]	
8/16-bit PPG ch1 (Lower)	IRQ9	FFE8 _H	FFE9 _H	L09 [1 : 0]	
8/16-bit PPG ch1 (Upper)	IRQ10	FFE6 _H	FFE7 _H	L10 [1 : 0]	
16-bit reload timer ch0	IRQ11	FFE4 _H	FFE5 _H	L11 [1 : 0]	
8/16-bit PPG ch0 (Upper)	IRQ12	FFE2 _H	FFE3 _H	L12 [1 : 0]	
8/16-bit PPG ch0 (Lower)	IRQ13	FFE0 _H	FFE1 _H	L13 [1 : 0]	
8/16-bit compound timer ch1 (Upper)	IRQ14	FFDE _H	FFDF _H	L14 [1 : 0]	
16-bit PPG ch0	IRQ15	FFDC _H	FFDD _H	L15 [1 : 0]	
I ² C ch0	IRQ16	FFDA _H	FFDB _H	L16 [1 : 0]	
16-bit PPG ch1	IRQ17	FFD8 _H	FFD9 _H	L17 [1 : 0]	
10-bit A/D converter	IRQ18	FFD6 _H	FFD7 _H	L18 [1 : 0]	
Timebase timer	IRQ19	FFD4 _H	FFD5 _H	L19 [1 : 0]	
Watch timer/counter	IRQ20	FFD2 _H	FFD3 _H	L20 [1 : 0]	
External interrupt ch8	IRQ21	FFD0 _H	FFD1 _H	L21 [1 : 0]	
External interrupt ch9					
External interrupt ch10					
External interrupt ch11					
8/16-bit compound timer ch1 (Lower)	IRQ22	FFCE _H	FFCF _H	L22 [1 : 0]	
FLASH	IRQ23	FFCC _H	FFCD _H	L23 [1 : 0]	

■ ELECTRICAL CHARACTERISTICS

1. Absolute Maximum Ratings

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power supply voltage*1	V _{CC} AV _{CC}	V _{SS} – 0.3	V _{SS} + 4.0	V	*2
	AVR	V _{SS} – 0.3	V _{SS} + 4.0		*2
Input voltage*1	V _{I1}	V _{SS} – 0.3	V _{SS} + 4.0	V	Other than P50, P51, P80 to P83*3
	V _{I2}	V _{SS} – 0.3	V _{SS} + 6.0		P50, P51, P80 to P83
Output voltage*1	V _O	V _{SS} – 0.3	V _{SS} + 4.0	V	*3
Maximum clamp current	I _{CLAMP}	– 2.0	+ 2.0	mA	Applicable to pins*4
Total maximum clamp current	Σ I _{CLAMP}	—	20	mA	Applicable to pins*4
“L” level maximum output current	I _{OL1}	—	15	mA	Other than P00 to P07
	I _{OL2}		15		P00 to P07
“L” level average current	I _{OLAV1}	—	4	mA	Other than P00 to P07 Average output current = operating current × operating ratio (1 pin)
	I _{OLAV2}		12		P00 to P07 Average output current = operating current × operating ratio (1 pin)
“L” level total maximum output current	ΣI _{OL}	—	100	mA	
“L” level total average output current	ΣI _{OLAV}	—	50	mA	Total average output current = operating current × operating ratio (Total of pins)
“H” level maximum output current	I _{OH1}	—	– 15	mA	Other than P00 to P07
	I _{OH2}		– 15		P00 to P07
“H” level average current	I _{OHAV1}	—	– 4	mA	Other than P00 to P07 Average output current = operating current × operating ratio (1 pin)
	I _{OHAV2}		– 8		P00 to P07 Average output current = operating current × operating ratio (1 pin)
“H” level total maximum output current	ΣI _{OH}	—	– 100	mA	
“H” level total average output current	ΣI _{OHAV}	—	– 50	mA	Total average output current = operating current × operating ratio (Total of pins)

(Continued)

MB95100A Series

(Continued)

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power consumption	Pd	—	320	mW	
Operating temperature	T _A	- 40	+ 85	°C	Other than MB95FV100A-101
Storage temperature	T _{stg}	- 55	+ 150	°C	

*1 : The parameter is based on $AV_{SS} = V_{SS} = 0.0 \text{ V}$.

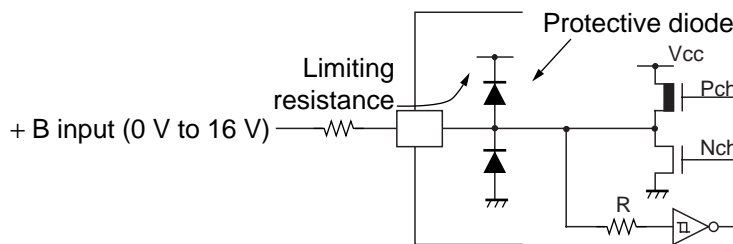
*2 : Apply equal potential to AV_{CC} and V_{CC} . AVR should not exceed $AV_{CC} + 0.3 \text{ V}$.

*3 : V_{I1} and V_o should not exceed $V_{CC} + 0.3 \text{ V}$. V_{I1} must not exceed the rating voltage. However, if the maximum current to/from an input is limited by some means with external components, the I_{CLAMP} rating supersedes the V_{I1} rating.

*4 : Applicable to pins : P00 to P07, P10 to P14, P20 to P24, P30 to P37, P40 to P43, P52, P53, P70, P71, PE0 to PE3, PG0

- Use within recommended operating conditions.
- Use at DC voltage (current).
- The + B signal should always be applied a limiting resistance placed between the + B signal and the microcontroller.
- The value of the limiting resistance should be set so that when the + B signal is applied the input current to the microcontroller pin does not exceed rated values, either instantaneously or for prolonged periods.
- Note that when the microcontroller drive current is low, such as in the power saving modes, the +B input potential may pass through the protective diode and increase the potential at the VCC pin, and this may affect other devices.
- Note that if the + B signal is inputted when the microcontroller power supply is off (not fixed at 0 V), the power supply is provided from the pins, so that incomplete operation may result.
- Note that if the + B input is applied during power-on, the power supply is provided from the pins and the resulting power supply voltage may not be sufficient to operate the power-on reset.
- Care must be taken not to leave the + B input pin open.
- Sample recommended circuits :

• Input/Output Equivalent circuits



WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

2. Recommended Operating Conditions

(AVss = Vss = 0.0 V)

Parameter	Symbol	Value		Unit	Remarks
		Min	Max		
Power supply voltage	V _{CC} , AV _{CC}	1.8*1	3.3*2	V	At normal operating, FLASH product, T _A = -10 °C to +85 °C
		1.8*1	3.6		At normal operating, MASK product, T _A = -10 °C to +85 °C
		2.0*1	3.3*2		At normal operating, FLASH product, T _A = -40 °C to +85 °C
		2.0*1	3.6		At normal operating, MASK product, T _A = -40 °C to +85 °C
		2.6	3.6		MB95FV100A-101
		1.5	3.3*2		Retain status of stop operation, FLASH product
		1.5	3.6		Retain status of stop operation, MASK product
A/D converter reference input voltage	AVR	1.8	AV _{CC}		
Operating temperature	T _A	- 40	+ 85	°C	Other than MB95FV100A-101

*1 : The values vary with the operating frequency.

*2 : Consult Fujitsu separately for a guarantee of a maximum value of 3.6 V.

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

MB95100A Series

3. DC Characteristics

($V_{CC} = AV_{CC} = 3.3\text{ V}$, $AV_{SS} = V_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^\circ\text{C}$ to $+85\text{ }^\circ\text{C}$ [MB95FV100A-101 is $T_A = +25\text{ }^\circ\text{C}$])

Parameter	Sym- bol	Pin name	Condi- tions	Value			Unit	Remarks
				Min	Typ	Max		
"H" level input voltage	V_{IH1}	P10, P67	*1	$0.7 V_{CC}$	—	$V_{CC} + 0.3$	V	At selecting of CMOS input level (hysteresis input)
	V_{IH2}	P50, P51	*1	$0.7 V_{CC}$	—	$V_{SS} + 5.5$	V	At selecting of CMOS input level (hysteresis input)
	V_{IHS1}	P00 to P07, P10 to P14, P20 to P24, P30 to P37, P40 to P43, P52, P53, P60 to P67, P70, P71, PE0 to PE3, PG0, PG1*2, PG2*2	*1	$0.8 V_{CC}$	—	$V_{CC} + 0.3$	V	Hysteresis input
	V_{IHS2}	P50, P51, P80 to P83	*1	$0.8 V_{CC}$	—	$V_{SS} + 5.5$	V	Hysteresis input
	V_{IHM}	\overline{RST} , MOD	—	$0.7 V_{CC}$	—	$V_{CC} + 0.3$	V	CMOS input (FLASH product)
			—	$0.8 V_{CC}$	—	$V_{CC} + 0.3$	V	Hysteresis input (MASK product)
"L" level input voltage	V_{IL}	P10, P50, P51, P67	*1	$V_{SS} - 0.3$	—	$0.3 V_{CC}$	V	At selecting of CMOS input level (hysteresis input)
	V_{ILS}	P00 to P07, P10 to P14, P20 to P24, P30 to P37, P40 to P43, P50 to P53, P60 to P67, P70, P71, P80 to P83, PE0 to PE3, PG0, PG1*2, PG2*2	*1	$V_{SS} - 0.3$	—	$0.2 V_{CC}$	V	Hysteresis input
	V_{ILM}	\overline{RST} , MOD	—	$V_{SS} - 0.3$	—	$0.3 V_{CC}$	V	CMOS input (FLASH product)
			—	$V_{SS} - 0.3$	—	$0.2 V_{CC}$	V	Hysteresis input (MASK product)
Open-drain output application voltage	V_D	P50, P51, P80 to P83	—	$V_{SS} - 0.3$	—	$V_{SS} + 5.5$	V	
"H" level output voltage	V_{OH1}	Output pin other than P00 to P07	$I_{OH} =$ -4.0 mA	2.4	—	—	V	MB95FV100A-101 a conditional : $I_{OH} = -2.0\text{ mA}$
	V_{OH2}	P00 to P07	$I_{OH} =$ -8.0 mA	2.4	—	—	V	MB95FV100A-101 a conditional : $I_{OH} = -5.0\text{ mA}$

(Continued)

MB95100A Series

($V_{CC} = AV_{CC} = 3.3\text{ V}$, $AV_{SS} = V_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^\circ\text{C}$ to $+85\text{ }^\circ\text{C}$ [MB95FV100A-101 is $T_A = +25\text{ }^\circ\text{C}$])

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
“L” level output voltage	V_{OL1}	Output pin other than P00 to P07	$I_{OL} = 4.0\text{ mA}$	—	—	0.4	V	MB95FV100A-101 a conditional : $I_{OL} = 3.0\text{ mA}$
	V_{OL2}	P00 to P07	$I_{OL} = 12\text{ mA}$	—	—	0.4	V	MB95FV100A-101 a conditional : $I_{OL} = 8.0\text{ mA}$
Input leakage current (High-Z output leakage current)	I_{LI}	Port other than P50, P51, P80 to P83	$0.0\text{ V} < V_i < V_{CC}$	-5	—	+5	μA	When no pull-up resistor is specified
Open-drain output leakage current	I_{LIOD}	P50, P51, P80 to P83	$0.0\text{ V} < V_i < V_{SS} + 5.5\text{ V}$	—	—	+5	μA	
Pull-up resistor	R_{PULL}	P10 to P14, P20 to P24, P30 to P37, P40 to P43, P52, P53, P70, P71, PE0 to PE3, PG0, PG1*2, PG2*2	$V_i = 0.0\text{ V}$	25	50	100	$\text{k}\Omega$	When specifying pull-up resistor
Pull-down resistor	R_{MOD}	MOD	$V_i = V_{CC}$	50	100	200	$\text{k}\Omega$	MASK product only
Power supply current*3	I_{CC}	Vcc (External clock operation)	$F_{CH} = 20\text{ MHz}$ $f_{mp} = 10\text{ MHz}$ Main clock mode (divided by 2)	—	11	14	mA	FLASH product
				—	7.3	10	mA	MASK product
				—	30	35	mA	FLASH product (at FLASH writing and erasing)
	I_{CCS}		$F_{CH} = 20\text{ MHz}$ $f_{mp} = 10\text{ MHz}$ Main Sleep mode (divided by 2)	—	4.5	6	mA	
	I_{CCL}		$F_{CL} = 32\text{ kHz}$ $f_{mpl} = 16\text{ kHz}$ Subclock mode (divided by 2) , $T_A = +25\text{ }^\circ\text{C}$	—	25	35	μA	
I_{CCLS}	$F_{CL} = 32\text{ kHz}$ $f_{mpl} = 16\text{ kHz}$ Sub sleep mode (divided by 2) , $T_A = +25\text{ }^\circ\text{C}$	—	7	15	μA			

(Continued)

MB95100A Series

(Continued)

($V_{CC} = AV_{CC} = 3.3\text{ V}$, $AV_{SS} = V_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$ [MB95FV100A-101 is $T_A = +25\text{ }^{\circ}\text{C}$])

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Power supply current*3	I _{CC} T	V _{CC} (External clock operation)	F _{CL} = 32 kHz Watch mode	—	2	10	μA	FLASH product
			Main stop mode T _A = +25 °C	—	1	5	μA	MASK product
	I _{CC} MPLL		F _{CH} = 4 MHz f _{mp} = 10 MHz	—	10	14	mA	FLASH product
			Main PLL mode (multiplied by 2.5)	—	6.7	10	mA	MASK product
	I _{CC} SPLL		F _{CL} = 32 kHz f _{mpl} = 128 kHz Sub PLL mode (multiplied by 4), T _A = +25 °C	—	190	250	μA	
	I _{CT} S		F _{CH} = 10 MHz Timebase timer mode T _A = +25 °C	—	0.4	0.5	mA	
	I _{CC} H		Sub stop mode T _A = +25 °C	—	1	5	μA	
	I _A		F _{CH} = 10 MHz At operating of A/D conversion	—	1.3	2.2	mA	
I _{AH}	F _{CH} = 10 MHz At stopping A/D conversion T _A = +25 °C	—	1	5	μA			
Input capacitance	C _{IN}	Other than AV _{CC} , AV _{SS} , AVR, V _{CC} , V _{SS}	—	—	5	15	pF	

*1 : P10, P50, P51, and P67 can switch the input level to either the CMOS input level or hysteresis input level.
The switching of the input level can be set by the input level selection register (ILSR).

*2 : Single-clock product only

*3 : The power-supply current is determined by the external clock.

- Refer to "4. AC characteristics (1) Clock Timing" for F_{CH} and F_{CL}.
- Refer to "4. AC characteristics (2) Source Clock/Machine Clock" for f_{mp} and f_{mpl}.

4. AC Characteristics

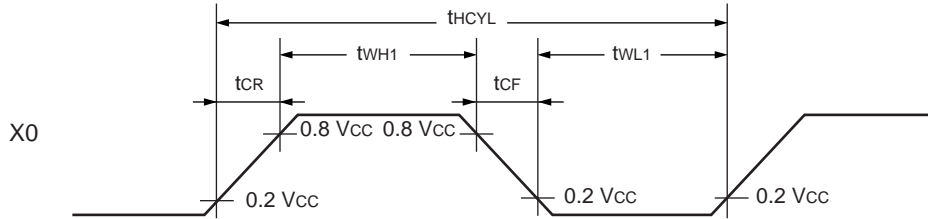
(1) Clock Timing

(V_{CC} = 3.3 V, AV_{SS} = V_{SS} = 0.0 V, T_A = - 40 °C to + 85 °C)

Parameter	Symbol	Pin	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Clock frequency	F _{CH}	X0, X1	—	1	—	10	MHz	When using Main oscillation circuit
				1	—	20	MHz	When using external clock
				3	—	10	MHz	Main PLL multiplied by 1
				3	—	5	MHz	Main PLL multiplied by 2
				3	—	4	MHz	Main PLL multiplied by 2.5
Clock frequency	F _{CL}	X0A, X1A	—	—	32.768	—	kHz	When using Sub oscillation circuit
				—	32.768	—	kHz	When using sub PLL FLASH product : V _{CC} = 2.3 V to 3.3 V MASK product : V _{CC} = 2.3 V to 3.6 V
Clock cycle time	t _{H CYL}	X0, X1	—	100	—	1000	ns	When using Main oscillation circuit
				50	—	1000	ns	When using external clock
	t _{L CYL}	X0A, X1A		—	30.5	—	μs	When using Sub oscillation circuit
Input clock pulse width	t _{WH1} t _{WL1}	X0	—	10	—	—	ns	When using external clock Duty ratio is about 30% to 70%.
	t _{WH2} t _{WL2}	X0A		—	15.2	—	μs	
Input clock rise time and fall time	t _{CR} t _{CF}	X0, X0A	—	—	5	ns	When using external clock	

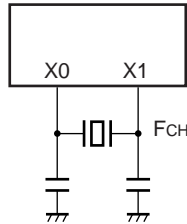
MB95100A Series

- X0 and X1 Timing and Applying Conditions

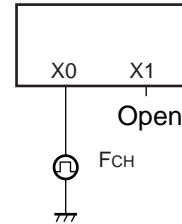


- Main Clock Applying Conditions

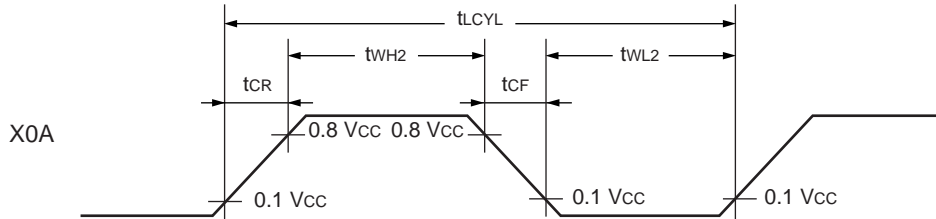
When using a crystal or ceramic oscillator



When using external clock

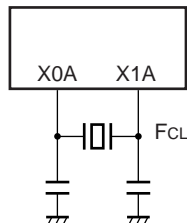


- X0A and X1A Timing and Applying Conditions

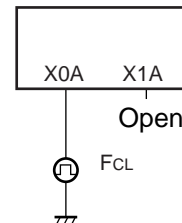


- SubClock Applying Conditions

When using a crystal or ceramic oscillator



When using external clock



(2) Source Clock/Machine Clock

(V_{CC} = 3.3 V, AV_{SS} = V_{SS} = 0.0 V, T_A = -40 °C to +85 °C)

Parameter	Symbol	Pin name	Value			Unit	Remarks
			Min	Typ	Max		
Source clock* ¹ (Clock before setting division)	SCLK	—	100	—	2000	ns	When using Main clock Min : F _{CH} = 10 MHz, PLL multiplied by 1 Max : F _{CH} = 1 MHz, divided by 2
			7.6	—	61.0	μs	When using Subclock Min : F _{CL} = 32 kHz, PLL multiplied by 4 Max : F _{CL} = 32 kHz, divided by 2
Source clock frequency	fsp	—	0.5	—	10.0	MHz	When using Main clock
	fspl	—	16.384	—	131.072	kHz	When using Subclock
Machine clock* ² (Minimum instruction execution time)	MCLK	—	100	—	32000	ns	When using Main clock Min : SLCK = 10 MHz, no division Max : SLCK = 0.5 MHz, divided by 16
			7.6	—	976.5	μs	When using Subclock Min : SLCK = 131 kHz, no division Max : SLCK = 16 kHz, divided by 16
Machine clock frequency	fmp	—	0.031	—	10.000	MHz	When using Main clock
	fmpl	—	1.024	—	131.072	kHz	When using Subclock

*1 : Clock before setting division due to machine clock division ratio selection bit (SYCC : DIV1 and DIV0) . This source clock is divided by the machine clock division ratio selection bit (SYCC : DIV1 and DIV0) , and it becomes the machine clock. Further, the source clock can be selected as follow.

- Main clock divided by 2
- PLL multiplication of main clock (select from 1, 2, 2.5 multiplication)
- Subclock divided by 2
- PLL multiplication of subclock (select from 2, 3, 4 multiplication)

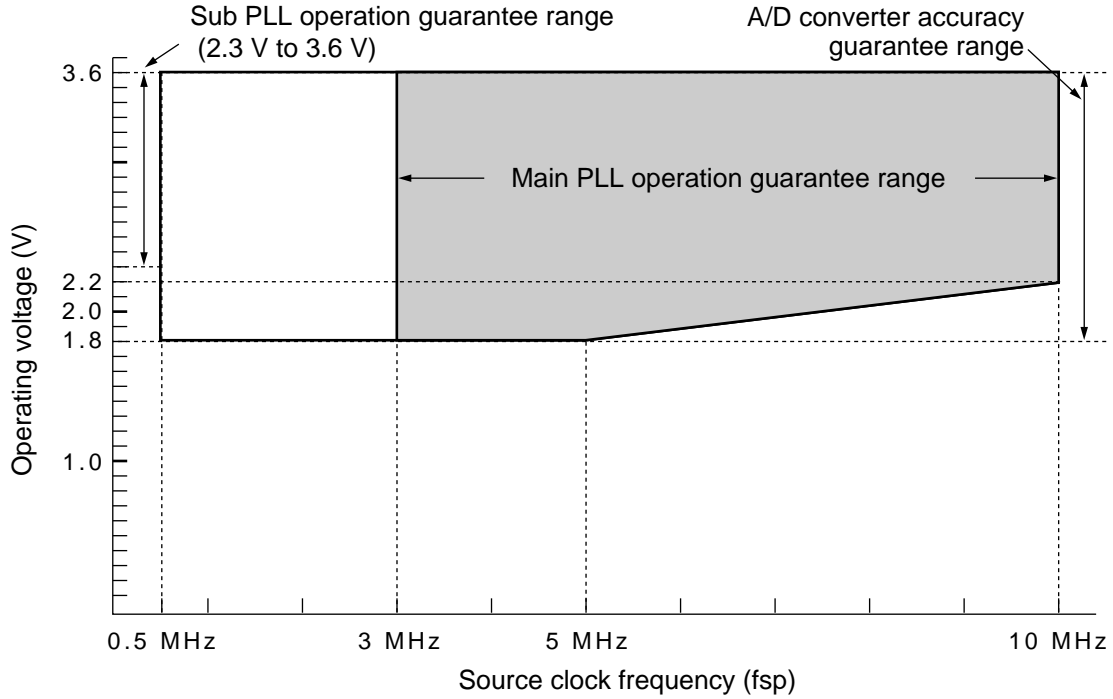
*2 : Operation clock of the microcontroller. Machine clock can be selected as follow.

- Source clock (no division)
- Source clock divided by 4
- Source clock divided by 8
- Source clock divided by 16

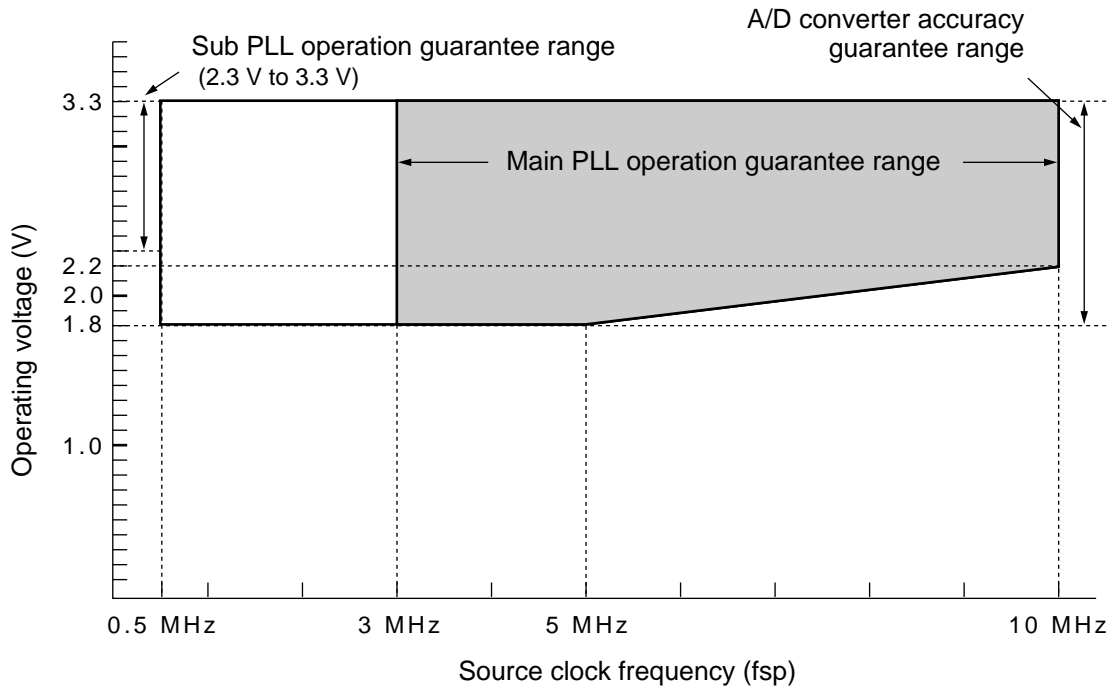
MB95100A Series

• Operating voltage - Operating frequency

• MASK product



• FLASH product

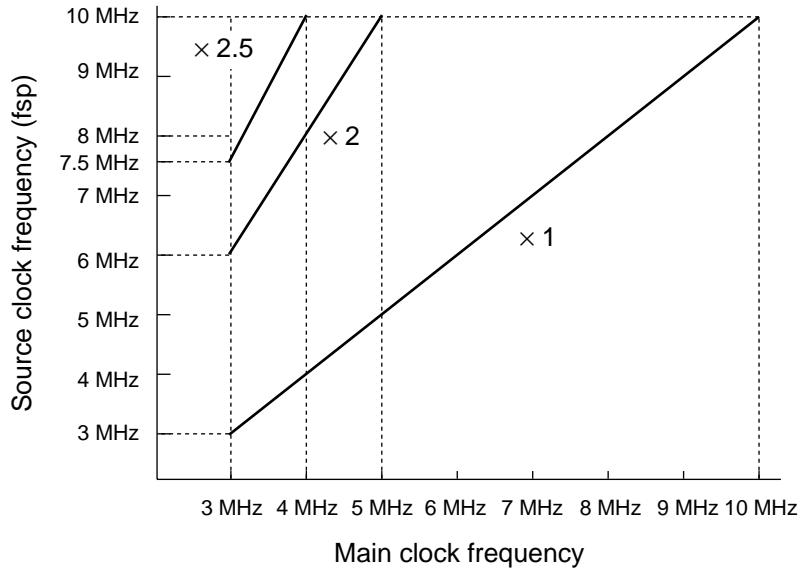


Note: In operating by 2.0 V or less, only "T_A = -10 °C to +85 °C" is guaranteed.

(Continued)

(Continued)

- Main PLL operation frequency



MB95100A Series

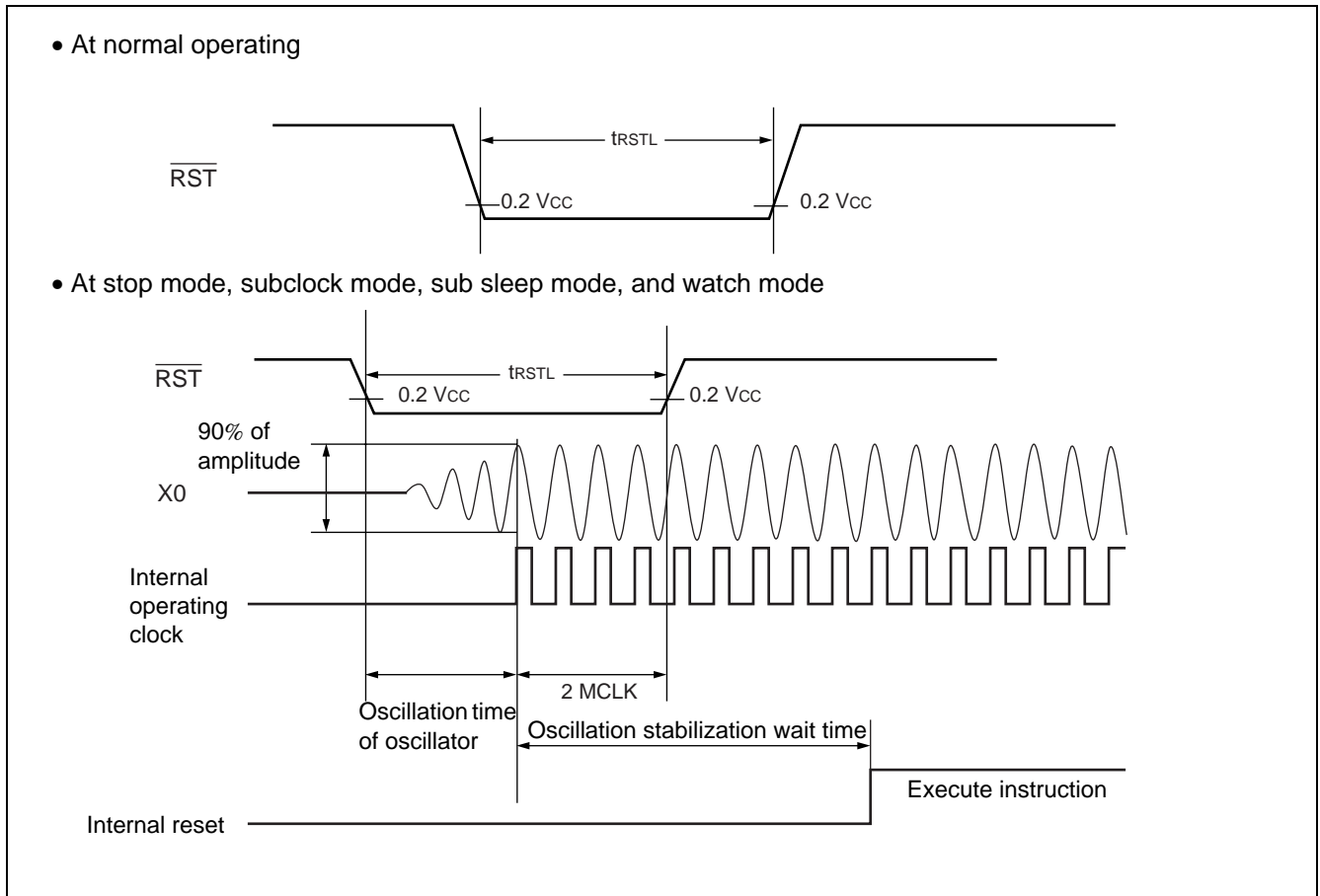
(3) Reset Timing

($V_{CC} = 3.3\text{ V}$, $A_{VSS} = V_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$)

Parameter	Symbol	Value		Unit	Remarks
		Min	Max		
$\overline{\text{RST}}$ "L" level pulse width	t_{RSTL}	2 MCLK^{*1}	—	ns	At normal operating
		Oscillation time of oscillator ^{*2} + 2 MCLK^{*1}	—	ns	At stop mode, subclock mode, sub sleep mode, and watch mode

*1 : Refer to " (2) Source Clock/Machine Clock" for MCLK.

*2 : Oscillation time of oscillator is the time that the amplitude reaches 90 %. In the crystal oscillator, the oscillation time is between several ms and tens of ms. In FAR/ceramic oscillators, the oscillation time is between hundreds of μs and several ms. In the external clock, the oscillation time is 0 ms.

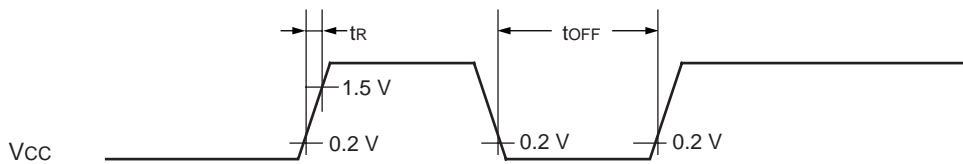


(4) Power-on Reset

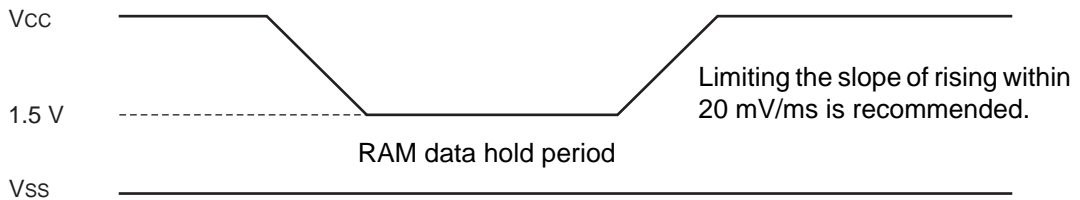
(AVss = Vss = 0.0 V, TA = - 40 °C to + 85 °C)

Parameter	Symbol	Conditions	Value		Unit	Remarks
			Min	Max		
Power supply rising time	t _R	—	—	36	ms	
Power supply cutoff time	t _{OFF}	—	1	—	ms	Due to repeated operations

Note : The power supply must be turned on within the selected oscillation stabilization time.



Sudden change of power supply voltage may activate the power-on reset function. When changing power supply voltages during operation, set the slope of rising within 20 mV/ms as shown below. In this case, do not use PLL clock. However, if voltage drop is 1V/s or less, use of PLL clock is allowed during operation.



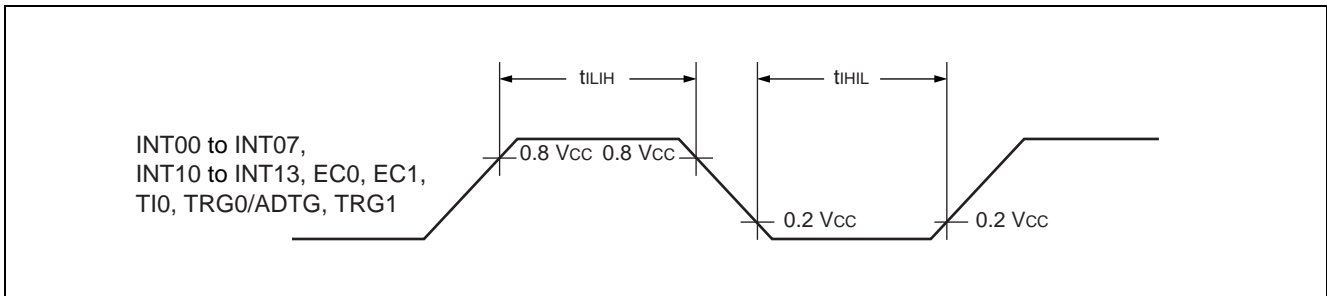
MB95100A Series

(5) Peripheral Input Timing

($V_{CC} = 3.3\text{ V}$, $AV_{SS} = V_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$)

Parameter	Symbol	Pin name	Value		Unit	Remarks
			Min	Max		
Peripheral input "H" pulse width	t_{LH}	INT00 to INT07, INT10 to INT13, EC0, EC1, TIO, TRG0/ADTG, TRG1	2 MCLK*	—	ns	
Peripheral input "L" pulse width	t_{HL}		2 MCLK*	—	ns	

* : Refer to "(2) Source Clock/Machine Clock" for MCLK.

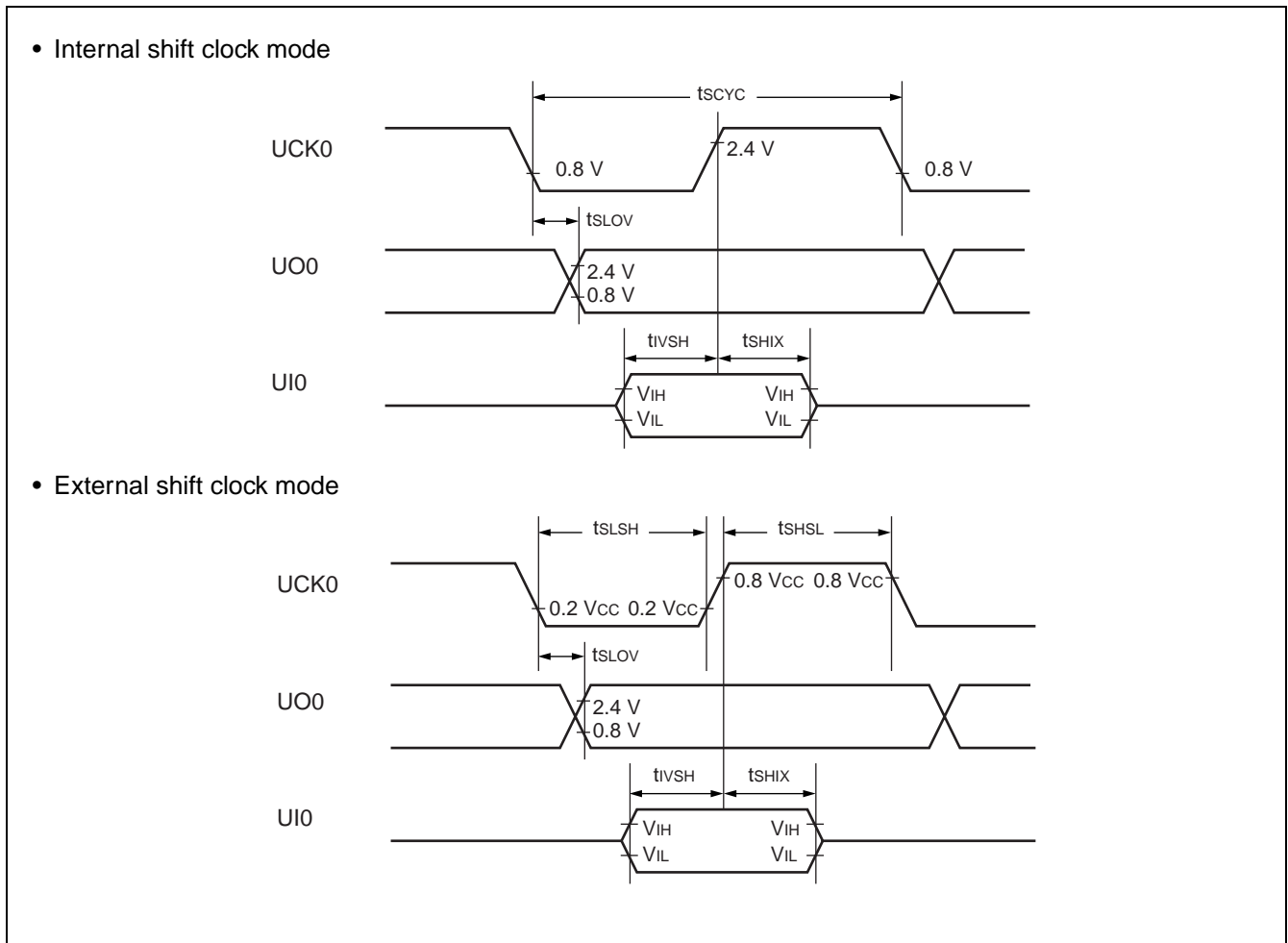


(6) UART/SIO, Serial I/O Timing

($V_{CC} = 3.3\text{ V}$, $AV_{SS} = V_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^\circ\text{C}$ to $+85\text{ }^\circ\text{C}$)

Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
Serial clock cycle time	t_{SCYC}	UCK0	Internal clock operation	4 MCLK*	—	ns	
UCK ↓ → UO time	t_{SLOV}	UCK0, UO0		- 190	190	ns	
Valid UI → UCK ↑	t_{VSH}	UCK0, UI0		2 MCLK*	—	ns	
UCK ↑ → valid UI hold time	t_{SHIX}	UCK0, UI0		2 MCLK*	—	ns	
Serial clock "H" pulse width	t_{SHSL}	UCK0	External clock operation	4 MCLK*	—	ns	
Serial clock "L" pulse width	t_{SLSH}	UCK0		4 MCLK*	—	ns	
UCK ↓ → UO time	t_{SLOV}	UCK0, UO0		—	190	ns	
Valid UI → UCK ↑	t_{VSH}	UCK0, UI0		2 MCLK*	—	ns	
UCK ↑ → valid UI hold time	t_{SHIX}	UCK0, UI0	2 MCLK*	—	ns		

* : Refer to "(2) Source Clock/Machine Clock" for MCLK.



MB95100A Series

(7) LIN-UART Timing

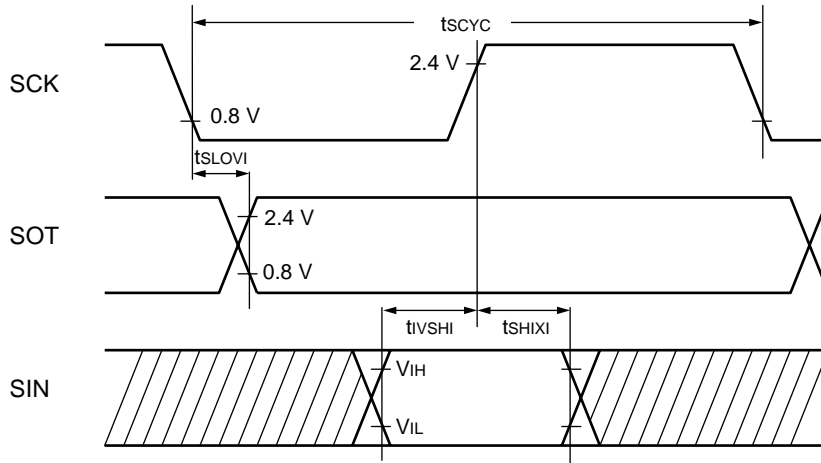
ESCR : SCES = 0, ECCR : SCDE = 0

(V_{CC} = 3.3 V, AV_{SS} = V_{SS} = 0.0 V, T_A = -40 °C to + 85 °C)

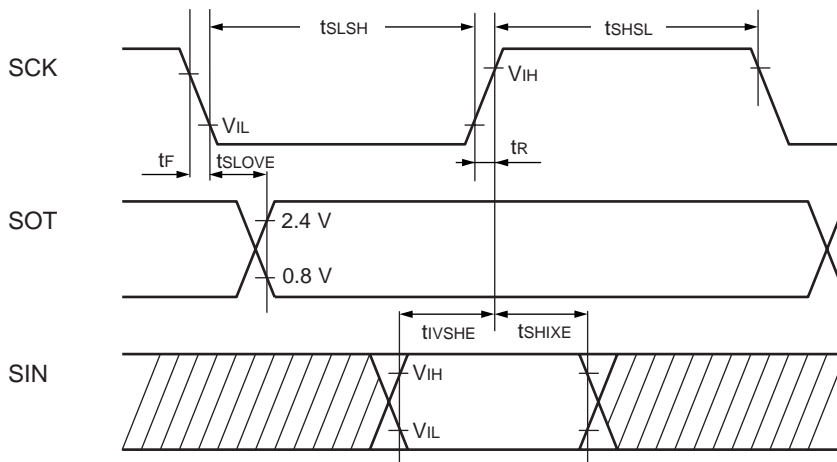
Parameter	Symbol	Pin name	Conditions	Value		Unit
				Min	Max	
Serial clock cycle time	t _{SCYC}	SCK	Internal clock operation output pin : C _L = 80 pF + 1 TTL	5 MCLK*	—	ns
SCK ↑→ SOT delay time	t _{SLOVI}	SCK, SOT		-95	95	ns
Valid SIN→SCK↑	t _{IVSHI}	SCK, SIN		MCLK* + 190	—	ns
SCK↑→ valid SIN hold time	t _{SHIXI}	SCK, SIN		0	—	ns
Serial clock "L" pulse width	t _{SLSH}	SCK	External clock operation output pin : C _L = 80 pF + 1 TTL	3 MCLK* - t _R	—	ns
Serial clock "H" pulse width	t _{SHSL}	SCK		MCLK* + 95	—	ns
SCK ↓→SOT delay time	t _{SLOVE}	SCK, SOT		—	2 MCLK* + 95	ns
Valid SIN→SCK↑	t _{IVSHE}	SCK, SIN		190	—	ns
SCK↑→ valid SIN hold time	t _{SHIXE}	SCK, SIN		MCLK* + 95	—	ns
SCK fall time	t _F	SCK		—	10	ns
SCK rise time	t _R	SCK		—	10	ns

* : Refer to "(2) Source Clock/Machine Clock" for MCLK.

- Internal shift clock mode



- External shift clock mode



MB95100A Series

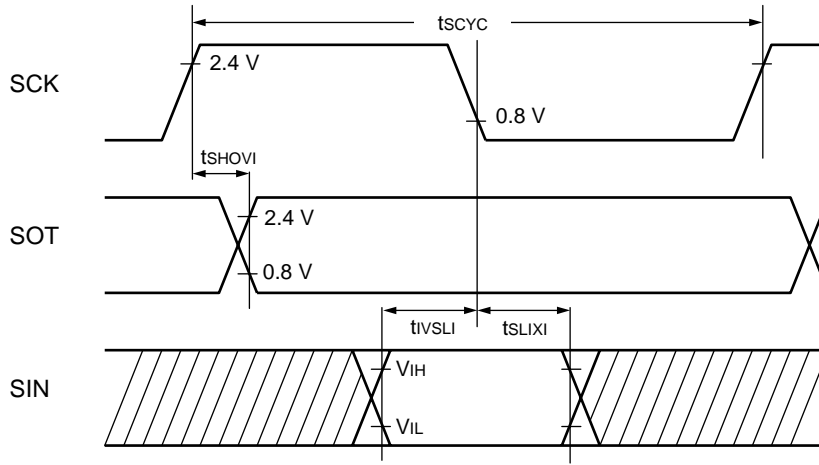
ESCR : SCES = 1, ECCR : SCDE = 0

(V_{CC} = 3.3 V, AV_{SS} = V_{SS} = 0.0 V, T_A = -40 °C to + 85 °C)

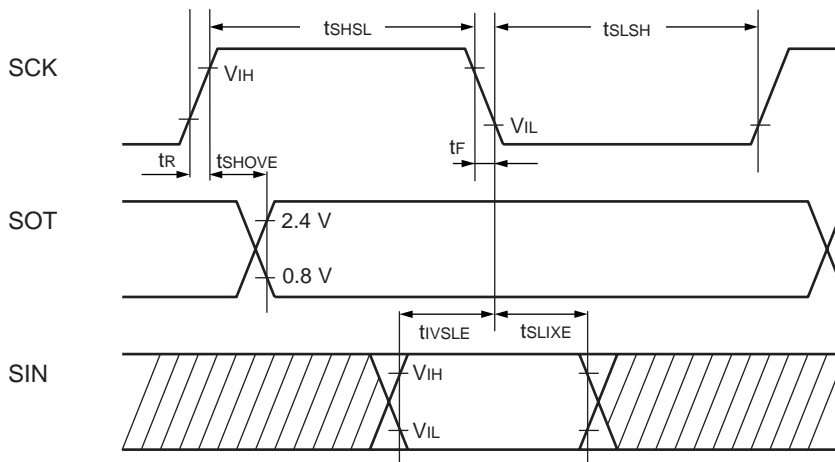
Parameter	Symbol	Pin name	Conditions	Value		Unit
				Min	Max	
Serial clock cycle time	t _{SCYC}	SCK	Internal clock operation output pin : C _L = 80 pF + 1 TTL	5 MCLK*	—	ns
SCK↑→ SOT delay time	t _{SHOVI}	SCK, SOT		-95	95	ns
Valid SIN→SCK↓	t _{IVSLI}	SCK, SIN		MCLK* + 190	—	ns
SCK↓→ valid SIN hold time	t _{SLIXI}	SCK, SIN		0	—	ns
Serial clock "H" pulse width	t _{SHSL}	SCK	External clock operation output pin : C _L = 80 pF + 1 TTL	3 MCLK* - t _R	—	ns
Serial clock "L" pulse width	t _{SLSH}	SCK		MCLK* + 95	—	ns
SCK↑ →SOT delay time	t _{SHOVE}	SCK, SOT		—	2 MCLK* + 95	ns
Valid SIN→SCK↓	t _{IVSLE}	SCK, SIN		190	—	ns
SCK↓→ valid SIN hold time	t _{SLIXE}	SCK, SIN		MCLK* + 95	—	ns
SCK fall time	t _F	SCK		—	10	ns
SCK rise time	t _R	SCK		—	10	ns

* : Refer to " (2) Source Clock/Machine Clock" for MCLK.

- Internal shift clock mode



- External shift clock mode



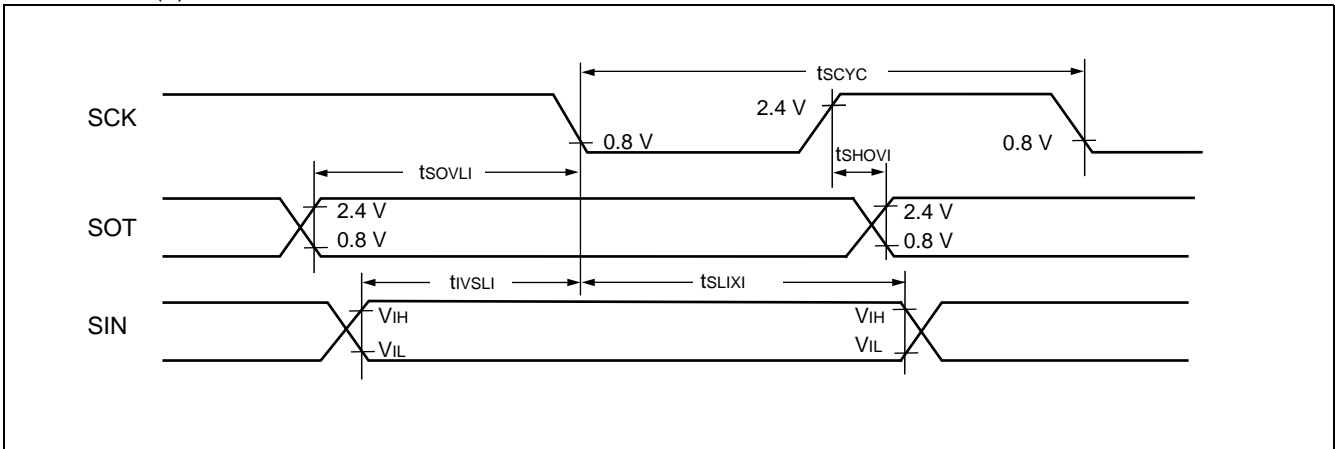
MB95100A Series

ESCR : SCES = 0, ECCR : SCDE = 1

(V_{CC} = 3.3 V, AV_{SS} = V_{SS} = 0.0 V, T_A = -40 °C to + 85 °C)

Parameter	Symbol	Pin name	Conditions	Value		Unit
				Min	Max	
Serial clock cycle time	t _{SCYC}	SCK	Internal clock operation output pin : C _L = 80 pF + 1 TTL	5 MCLK*	—	ns
SCK↑→ SOT delay time	t _{SHOVI}	SCK, SOT		-95	95	ns
Valid SIN→SCK↓	t _{IVSLI}	SCK, SIN		MCLK* + 190	—	ns
SCK↓→ valid SIN hold time	t _{SLIXI}	SCK, SIN		0	—	ns
SOT→SCK↓ delay time	t _{SOVLI}	SCK, SOT		—	4 MCLK*	ns

* : Refer to “ (2) Source Clock/Machine Clock” for MCLK.



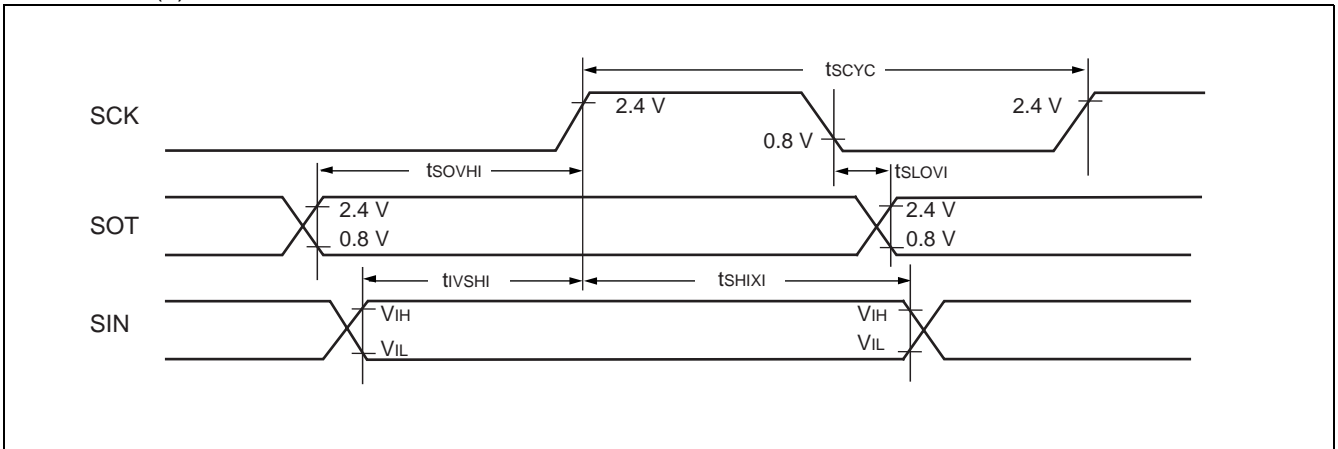
MB95100A Series

ESCR : SCES = 1, ECCR : SCDE = 1

(V_{CC} = 3.3 V, AV_{SS} = V_{SS} = 0.0 V, T_A = -40 °C to +85 °C)

Parameter	Symbol	Pin name	Conditions	Value		Unit
				Min	Max	
Serial clock cycle time	t _{SCYC}	SCK	Internal clock operating output pin : C _L = 80 pF + 1 TTL	5 MCLK*	—	ns
SCK↓→SOT hold time	t _{SLOVI}	SCK, SOT		-95	95	ns
Valid SIN→SCK↑	t _{IVSHI}	SCK, SIN		MCLK* + 190	—	ns
SCK↑ → valid SIN hold time	t _{SHIXI}	SCK, SIN		0	—	ns
SOT→SCK↑ delay time	t _{SOVHI}	SCK, SOT		—	4 MCLK*	ns

* : Refer to “(2) Source Clock/Machine Clock” for MCLK.



MB95100A Series

(8) I²C Timing

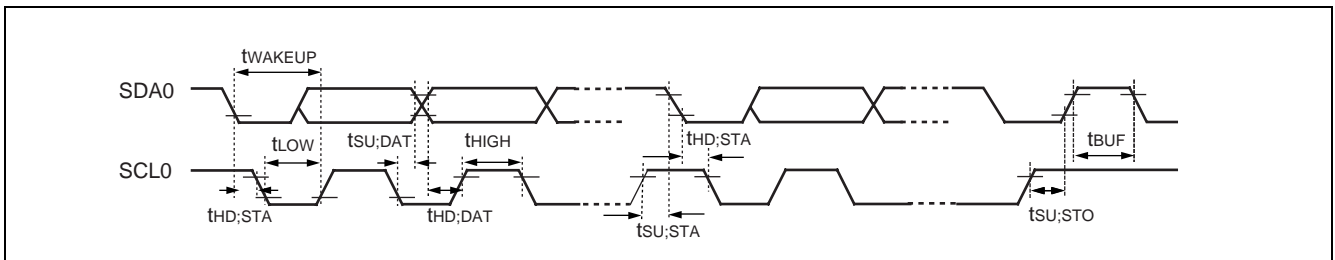
(V_{CC} = 3.3 V, AV_{SS} = V_{SS} = 0.0 V, T_A = -40 °C to +85 °C)

Parameter	Symbol	Conditions	Value				Unit	Remarks
			Standard-mode		Fast-mode			
			Min	Max	Min	Max		
SCL clock frequency	f _{SCL}	R = 1.7 kΩ, C = 50 pF*1	0	100	0	400	kHz	
(Repeat) Start condition hold time SDA ↓ → SCL ↓	t _{HD;STA}		4.0	—	0.6	—	μs	
SCL clock "L" width	t _{LOW}		4.7	—	1.3	—	μs	
SCL clock "H" width	t _{HIGH}		4.0	—	0.6	—	μs	
(Repeat) Start condition setup time SCL ↑ → SDA ↓	t _{SU;STA}		4.7	—	0.6	—	μs	
Data hold time SCL ↓ → SDA ↓ ↑	t _{HD;DAT}		0	3.45*2	0	0.9*3	μs	
Data setup time SDA ↓ ↑ → SCL ↑	t _{SU;DAT}		0.25	—	0.1	—	μs	
Stop condition setup time SCL ↑ → SDA ↑	t _{SU;STO}		4	—	0.6	—	μs	
Bus free time between stop condition and start condition	t _{BUF}		4.7	—	1.3	—	μs	

*1 : R, C : Pull-up resistor and load capacitor of the SCL and SDA lines.

*2 : The maximum t_{HD;DAT} have only to be met if the device dose not stretch the "L" width (t_{LOW}) of the SCL signal.

*3 : A Fast-mode I²C-bus device can be used in a Standard-mode I²C-bus system, but the requirement t_{SU;DAT} ≥ 250 ns must then be met.



MB95100A Series

(V_{CC} = 3.3 V, AV_{SS} = V_{SS} = 0.0 V, T_A = -40 °C to + 85 °C)

Parameter	Symbol	I/O Timing		Unit	Remarks
		Min	Max		
SCL clock "L" width	t _{LOW}	$(2 + nm^{*2} / 2)$ MCLK ^{*1} - 20	—	ns	Master mode
SCL clock "H" width	t _{HIGH}	$(nm^{*2} / 2)$ MCLK ^{*1} - 20	$(nm^{*2} / 2)$ MCLK ^{*1} + 20	ns	Master mode
Start condition hold time	t _{HD;STA}	$(-1 + nm^{*2} / 2)$ MCLK ^{*n1} - 20	$(-1 + nm^{*2})$ MCLK ^{*1} + 20	ns	Master mode Maximum value is applied when m, n = 1, 8. Otherwise, the minimum value is applied.
Stop condition setup time	t _{SU;STO}	$(1 + nm^{*2} / 2)$ MCLK ^{*n1} - 20	$(1 + nm^{*2} / 2)$ MCLK ^{*1} + 20	ns	Master mode
Start condition setup time	t _{SU;STA}	$(1 + nm^{*2} / 2)$ MCLK ^{*1} - 20	$(1 + nm^{*2} / 2)$ MCLK ^{*1} + 20	ns	Master mode
Bus free time between stop condition and start condition	t _{BUF}	$(2 nm^{*2} + 4)$ MCLK ^{*1} - 20	—	ns	
Data hold time	t _{HD;DAT}	3 MCLK ^{*1} - 20	—	ns	Master mode
Data setup time	t _{SU;DAT}	$(-2 + nm^{*2} / 2)$ MCLK ^{*1} - 20	$(-1 + nm^{*2} / 2)$ MCLK ^{*1} + 20	ns	Master mode When assuming that "L" of SCL is not extended, the minimum value is applied to first bit of continuous data. Otherwise, the maximum value is applied.
Setup time between clearing interrupt and SCL rising	t _{SU;INT}	$(nm^{*2} / 2)$ MCLK ^{*1} - 20	$(1 + nm^{*2} / 2)$ MCLK ^{*1} + 20	ns	Minimum value is applied to interrupt at 9th SCL↓. Maximum value is applied to interrupt at 8th SCL↓.
SCL clock "L" width	t _{LOW}	4 MCLK ^{*1} - 20	—	ns	At reception
SCL clock "H" width	t _{HIGH}	4 MCLK ^{*1} - 20	—	ns	At reception
Start condition detection	t _{HD;STA}	2 MCLK ^{*1} - 20	—	ns	Undetected when 1 MCLK is used at reception
Stop condition detection	t _{SU;STO}	2 MCLK ^{*1} - 20	—	ns	Undetected when 1 MCLK is used at reception
Restart condition detection condition	t _{SU;STA}	2 MCLK ^{*1} - 20	—	ns	Undetected when 1 MCLK is used at reception
Bus free time	t _{BUF}	2 MCLK ^{*1} - 20	—	ns	At reception
Data hold time	t _{HD;DAT}	2 MCLK ^{*1} - 20	—	ns	At slave transmission mode
Data setup time	t _{SU;DAT}	t _{LOW} - 3 MCLK ^{*1} - 20	—	ns	At slave transmission mode
Data hold time	t _{HD;DAT}	0	—	ns	At reception
Data setup time	t _{SU;DAT}	MCLK ^{*1} - 20	—	ns	At reception

(Continued)

MB95100A Series

(Continued)

(V_{CC} = 3.3 V, AV_{SS} = V_{SS} = 0.0 V, T_A = -40 °C to + 85 °C)

Parameter	Symbol	I/O Timing		Unit	Remarks
		Min	Max		
SDA↓→SCL↑ (at wakeup function)	t _{WAKE-UP}	Oscillation stabilization wait time + 2 MCLK*1 - 20	—	ns	

*1 : Refer to “ (2) Source Clock/Machine Clock” for MCLK.

*2 : • m is CS4 bit and CS3 bit (bit 4 and bit 3) of clock control register (ICCR) .

• n is CS2 bit to CS0 bit (bit 2 to bit 0) of clock control register (ICCR) .

• Actual timing of I²C is determined by m and n values set by the machine clock (MCLK) and ICCR [4 : 0].

• Standard-mode :

m and n can be set at the range : 0.9 MHz < MCLK (machine clock) < 10 MHz.

Setting of m and n determines the machine clock that can be used below.

(m, n) = (1, 8) : 0.9 MHz < MCLK ≤ 1 MHz

(m, n) = (1, 22), (5, 4), (6, 4), (7, 4), (8, 4) : 0.9 MHz < MCLK ≤ 2 MHz

(m, n) = (1, 38), (5, 8), (6, 8), (7, 8), (8, 8) : 0.9 MHz < MCLK ≤ 4 MHz

(m, n) = (1, 98) : 0.9 MHz < MCLK ≤ 10 MHz

• Fast-mode :

m and n can be set at the range : 3.3 MHz < MCLK (machine clock) < 10 MHz.

Setting of m and n determines the machine clock that can be used below.

(m, n) = (1, 8) : 3.3 MHz < MCLK ≤ 4 MHz

(m, n) = (1, 22), (5, 4) : 3.3 MHz < MCLK ≤ 8 MHz

(m, n) = (6, 4) : 3.3 MHz < MCLK ≤ 10 MHz

5. A/D Converter

(1) A/D Converter Electrical Characteristics

(AVcc = Vcc = 1.8 V to 3.3 V [FLASH product], AVcc = Vcc = 1.8 V to 3.6 V [MASK product], AVss = Vss = 0.0 V, TA = -40 °C to +85 °C)

Parameter	Symbol	Value			Unit	Remarks
		Min	Typ	Max		
Resolution	—	—	—	10	bit	
Total error		-3.0	—	+3.0	LSB	
Linearity error		-2.5	—	+2.5	LSB	
Differential linear error		-1.9	—	+1.9	LSB	
Zero transition voltage	V _{OT}	AVss - 1.5 LSB	AVss + 0.5 LSB	AVss + 2.5 LSB	V	FLASH product : 2.7 V ≤ AVcc ≤ 3.3 V MASK product : 2.7 V ≤ AVcc ≤ 3.6 V
		AVss - 0.5 LSB	AVss + 1.5 LSB	AVss + 3.5 LSB	V	1.8 V ≤ AVcc < 2.7 V
Full-scale transition voltage	V _{FST}	AVR - 3.5 LSB	AVR - 1.5 LSB	AVR + 0.5 LSB	V	FLASH product : 2.7 V ≤ AVcc ≤ 3.3 V MASK product : 2.7 V ≤ AVcc ≤ 3.6 V
		AVR - 2.5 LSB	AVR - 0.5 LSB	AVR + 1.5 LSB	V	1.8 V ≤ AVcc < 2.7 V
Compare time	—	0.6	—	16,500	μs	FLASH product : 2.7 V ≤ AVcc ≤ 3.3 V MASK product : 2.7 V ≤ AVcc ≤ 3.6 V
		20	—	16,500	μs	1.8 V ≤ AVcc < 2.7 V
Sampling time	—	0.4	—	∞	μs	FLASH product : 2.7 V ≤ AVcc ≤ 3.3 V MASK product : 2.7 V ≤ AVcc ≤ 3.6 V external impedance < at 1.8 kΩ
		30	—	∞	μs	1.8 V ≤ AVcc < 2.7 V external impedance < at 14.8 kΩ
Analog input current	I _{AIN}	-0.3	—	0.3	μA	
Analog input voltage range	V _{AIN}	AVss	—	AVR	V	
Reference voltage	—	AVss + 1.8	—	AVcc	V	AVR pin
Reference voltage supply current	I _R	—	400	600	μA	AVR pin, During A/D operation
	I _{RH}	—	—	5	μA	AVR pin, At stop mode

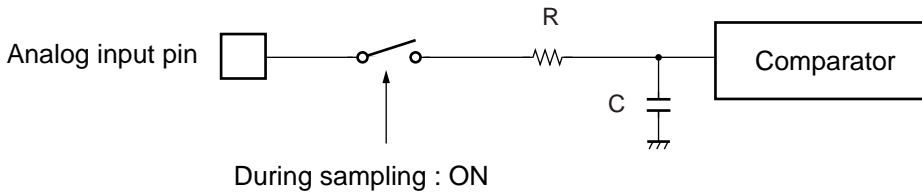
MB95100A Series

(2) Notes on Using A/D Converter

• About the external impedance of analog input and its sampling time

- A/D converter with sample and hold circuit. If the external impedance is too high to keep sufficient sampling time, the analog voltage charged to the internal sample and hold capacitor is insufficient, adversely affecting A/D conversion precision.

• Analog input circuit model



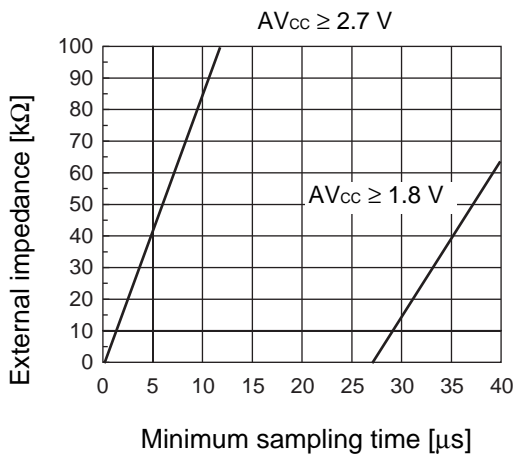
	R	C
$2.7 \text{ V} \leq AV_{CC} \leq 3.6 \text{ V}$	1.7 k Ω (Max)	14.5 pF (Max)
$1.8 \text{ V} \leq AV_{CC} < 2.7 \text{ V}$	84 k Ω (Max)	25.2 pF (Max)

Note : The values are reference values.

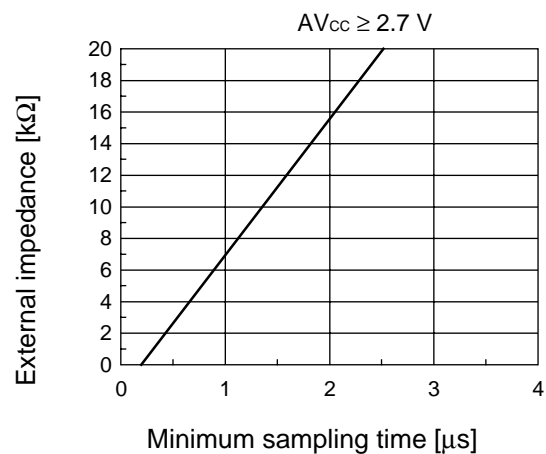
- To satisfy the A/D conversion precision standard, consider the relationship between the external impedance and minimum sampling time and either adjust the resistor value and operating frequency or decrease the external impedance so that the sampling time is longer than the minimum value.

• The relationship between external impedance and minimum sampling time

(External impedance = 0 k Ω to 100 k Ω)



(External impedance = 0 k Ω to 20 k Ω)



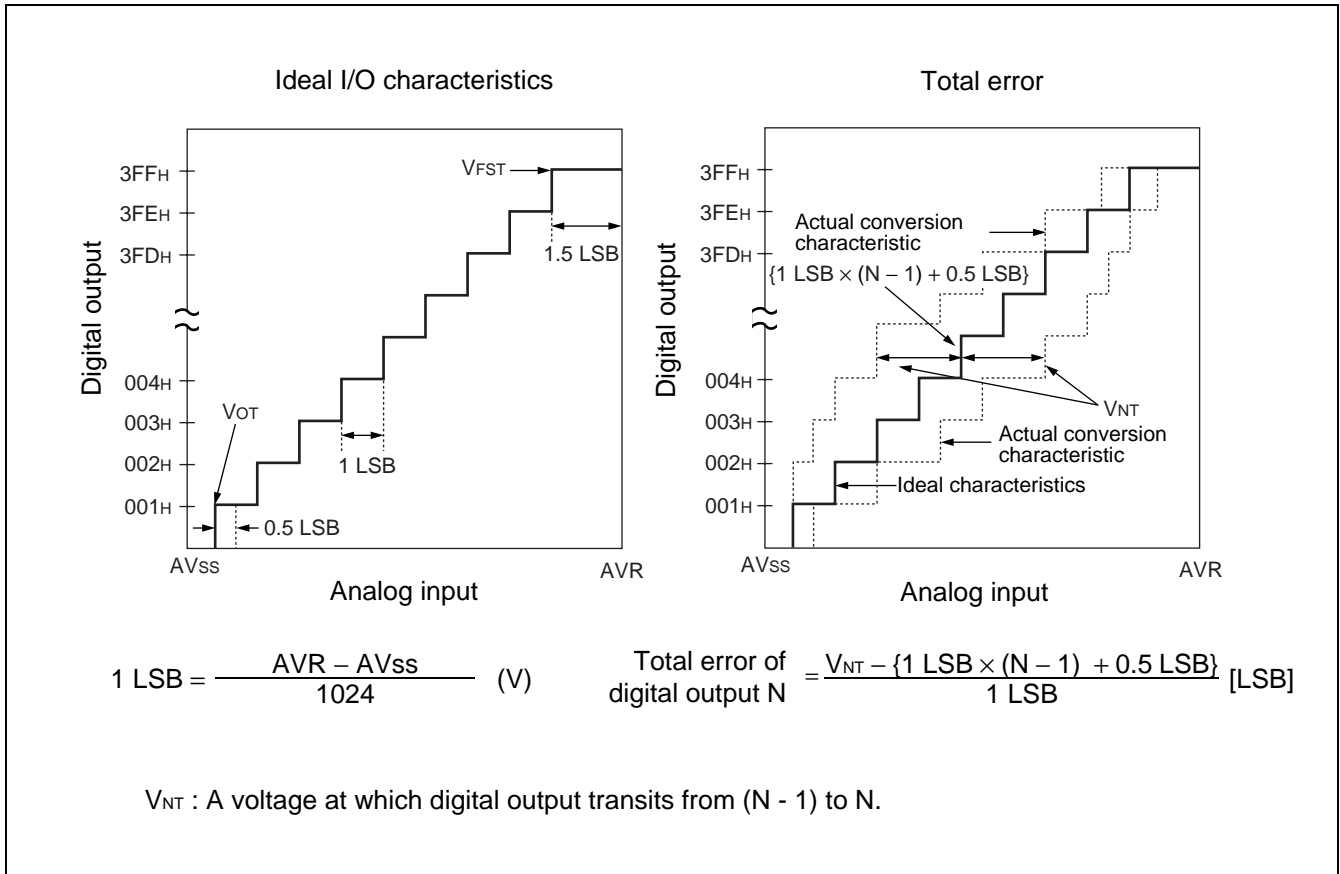
- If the sampling time cannot be sufficient, connect a capacitor of about 0.1 μF to the analog input pin.

• About errors

As $|AVR - AV_{SS}|$ becomes smaller, values of relative errors grow larger.

(3) Definition of A/D Converter Terms

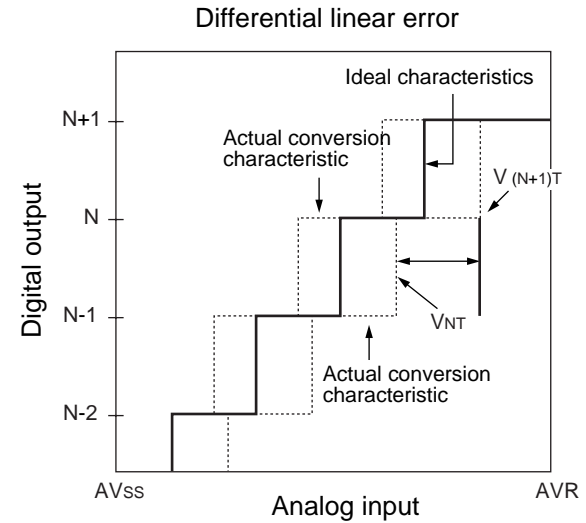
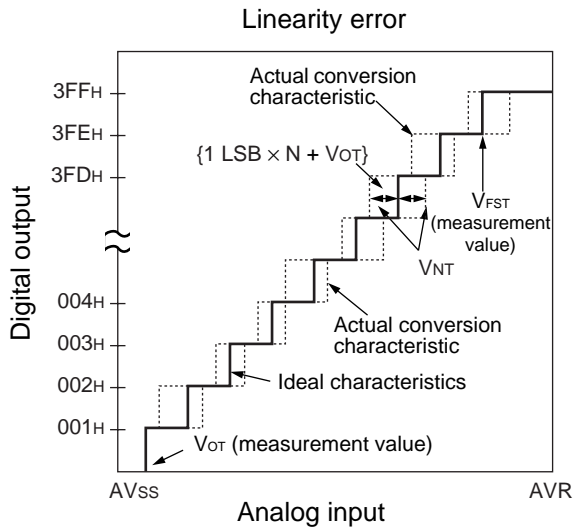
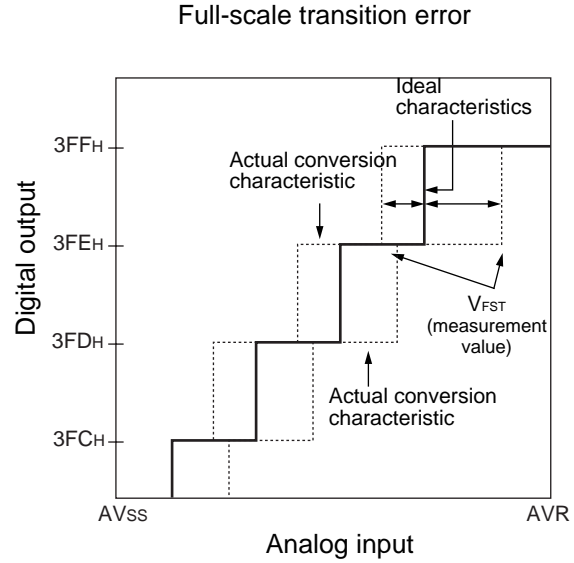
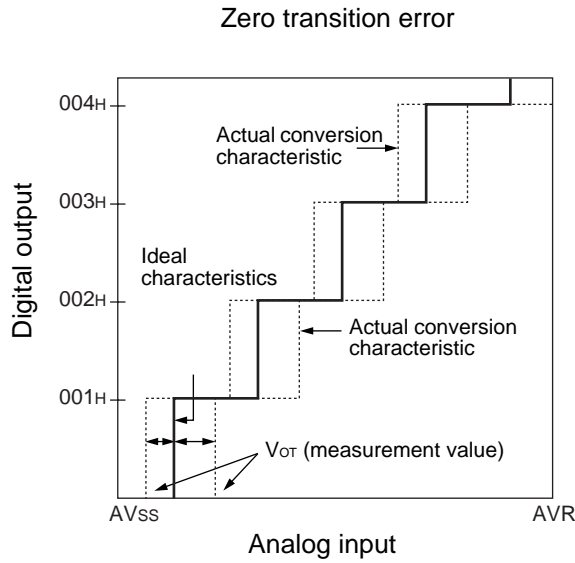
- Resolution
The level of analog variation that can be distinguished by the A/D converter.
When the number of bits is 10, analog voltage can be divided into $2^{10} = 1024$.
- Linearity error (unit : LSB)
The deviation between the value along a straight line connecting the zero transition point ("00 0000 0000" ← → "00 0000 0001") of a device and the full-scale transition point ("11 1111 1111" ← → "11 1111 1110") compared with the actual conversion values obtained.
- Differential linear error (Unit : LSB)
Deviation of input voltage, which is required for changing output code by 1 LSB, from an ideal value.
- Total error (unit: LSB)
Difference between actual and theoretical values, caused by a zero transition error, full-scale transition error, linearity error, quantum error, and noise.



(Continued)

MB95100A Series

(Continued)



$$\text{Linear error in digital output } N = \frac{V_{NT} - \{1 \text{ LSB} \times N + V_{OT}\}}{1 \text{ LSB}}$$

$$\text{Differential linear error in digital output } N = \frac{V_{(N+1)T} - V_{NT}}{1 \text{ LSB}} - 1$$

V_{NT} : A voltage at which digital output transits from (N - 1) to N.

V_{OT} (Ideal value) = AVSS + 0.5 LSB [V]

V_{FST} (Ideal value) = AVR - 1.5 LSB [V]

6. Flash Memory Program/Erase Characteristics

Parameter	Value			Unit	Remarks
	Min	Typ	Max		
Sector erase time (4 KB sector)	—	0.2* ¹	3* ²	s	Excludes 00 _H programming prior erasure.
Sector erase time (16 KB sector)	—	0.5* ¹	12* ²	s	Excludes 00 _H programming prior erasure.
Byte programming time	—	32	3600	μs	Excludes system-level overhead.
Erase/program cycle	10,000	—	—	cycle	
Power supply voltage at erase/ program	2.7	—	3.3	V	
Flash data retention time	20* ³	—	—	year	Average T _A = +85 °C

*1 : T_A = + 25 °C, V_{CC} = 3.0 V, 10000 cycles

*2 : T_A = + 85 °C, V_{CC} = 2.7 V, 10000 cycles

*3 : This value comes from the technology qualification (using Arrhenius equation to translate high temperature measurements into normalized value at +85 °C) .

MB95100A Series

■ MASK OPTION

No.	Part number	MB95107A	MB95F108AS	MB95F108AW	MB95FV100A-101
	Specifying procedure	Specify when ordering MASK	Setting disabled	Setting disabled	Setting disabled
1	Clock mode select • Single-system clock mode • Dual-system clock mode	Selectable	Single-system clock mode	Dual-system clock mode	Changing by the switch on MCU board
2	Selection of oscillation stabilization wait time • Selectable the initial value of main clock oscillation stabilization wait time	Selectable 1 : $(2^2-2) / F_{CH}$ 2 : $(2^{12}-2) / F_{CH}$ 3 : $(2^{13}-2) / F_{CH}$ 4 : $(2^{14}-2) / F_{CH}$	Fixed to oscillation stabilization wait time of $(2^{14}-2) / F_{CH}$	Fixed to oscillation stabilization wait time of $(2^{14}-2) / F_{CH}$	Fixed to oscillation stabilization wait time of $(2^{14}-2) / F_{CH}$

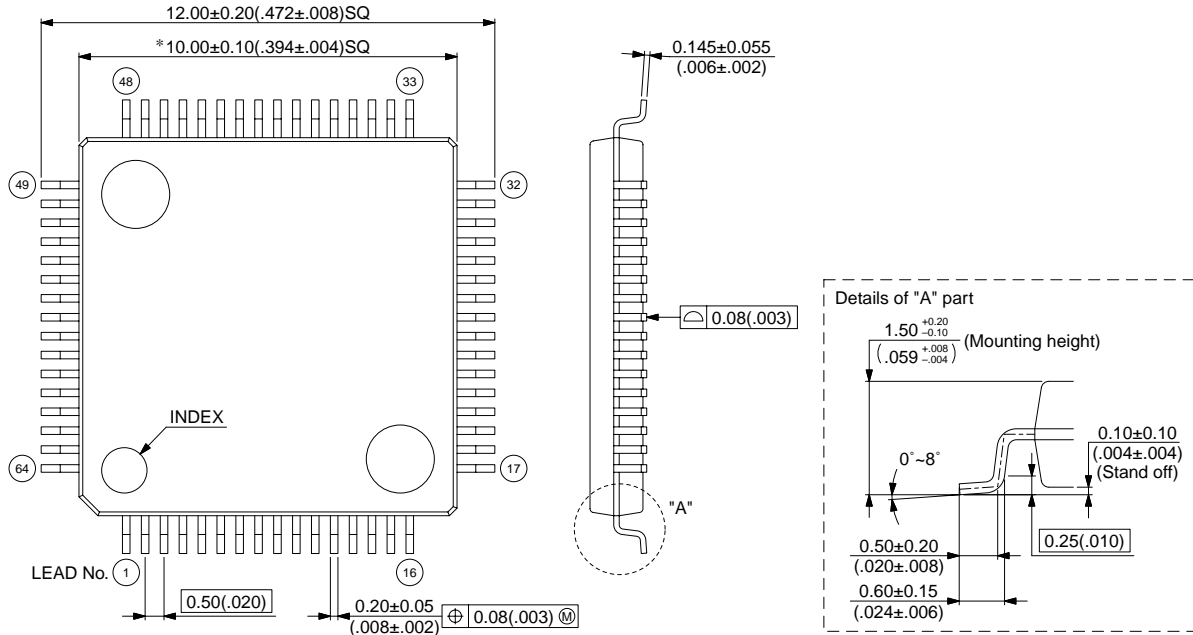
■ ORDERING INFORMATION

Part number	Package	Remarks
MB95107APFV MB95F108ASPFV MB95F108AWPFV	64-pin plastic LQFP (FPT-64P-M03)	
MB95107APFM MB95F108ASPFM MB95F108AWPFM	64-pin plastic LQFP (FPT-64P-M09)	
MB2146-301 (MB95FV100A-101PBT)	MCU board (224-pin plastic PFBGA) (BGA-224P-M08)	

■ PACKAGE DIMENSIONS

64-pin plastic LQFP
(FPT-64P-M03)

Note 1) * : These dimensions do not include resin protrusion.
 Note 2) Pins width and pins thickness include plating thickness.
 Note 3) Pins width do not include tie bar cutting remainder.



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Dimensions in mm (inches).

Note: The values in parentheses are reference values.

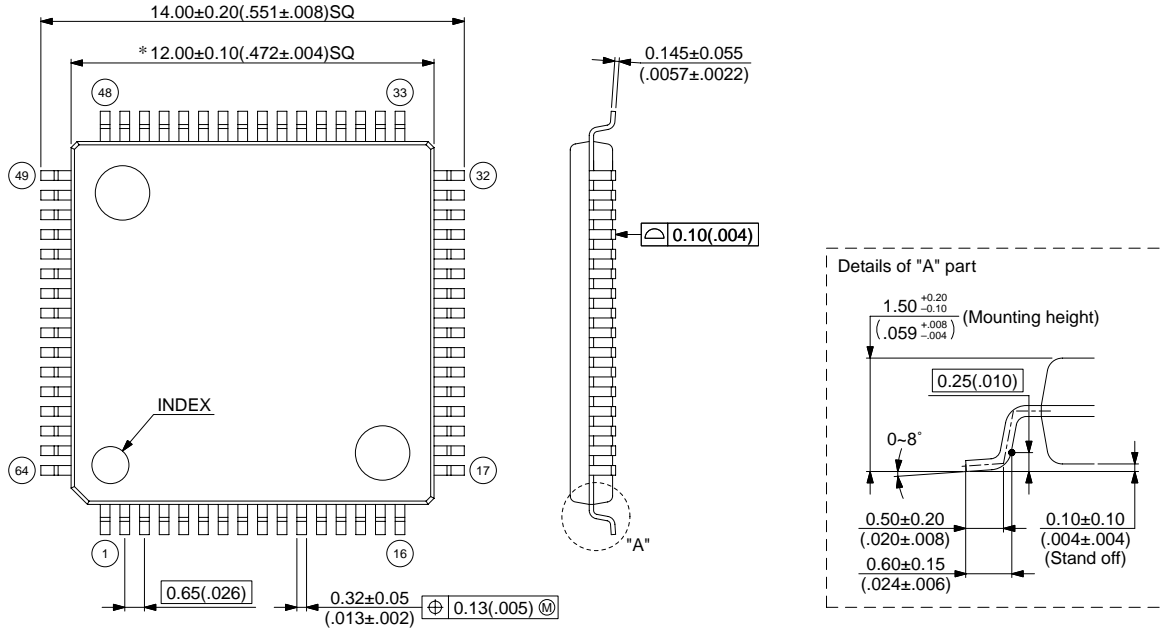
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MB95100A Series

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64-pin plastic LQFP
(FPT-64P-M09)

- Note 1) * : These dimensions do not include resin protrusion.
- Note 2) Pins width and pins thickness include plating thickness.
- Note 3) Pins width do not include tie bar cutting remainder.



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Dimensions in mm (inches).

Note: The values in parentheses are reference values.

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